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CYW4356/CG8674

Single-Chip 5G WiFi IEEE 802.11ac 2×2 MAC/ Baseband/Radio with Integrated Bluetooth 5.0

The Cypress CYW4356 is a complete dual-band (2.4 GHz and 5 GHz) 5G WiFi 2 × 2 MIMO MAC/PHY/Radio System-on-a-Chip. This Wi-Fi single-chip device provides a high level of integration with dual-stream IEEE 802.11ac MAC/baseband/radio, Bluetooth 5.0. Additionally, it supports wireless charging. In IEEE 802.11ac mode, the WLAN operation supports rates of MCS0–MCS9 (up to 256 QAM) in 20 MHz, 40 MHz, and 80 MHz channels for data rates up to 867 Mbps. In addition, all the rates specified in IEEE 802.11a/ b/g/n are supported. Included on-chip are 2.4 GHz and 5 GHz transmit power amplifiers and receive low noise amplifiers.

ADVANCE

For the WLAN section, several alternative host interface options are included: an SDIO v3.0 interface that can operate in 4b or 1b modes, and a PCIe v3.0 compliant interface running at Gen1 speeds. For the Bluetooth section, host interface options of a high-speed 4-wire UART and USB 2.0 full-speed (12 Mbps) are provided.

The CYW4356 uses advanced design techniques and process technology to reduce active and idle power, and includes an embedded power management unit that simplifies the system power topology.

In addition, the CYW4356 implements highly sophisticated enhanced collaborative coexistence hardware mechanisms and algorithms that ensure that WLAN and Bluetooth collaboration is optimized for maximum performance. Coexistence support for external radios (such as LTE cellular and GPS) is provided via an external interface. As a result, enhanced overall quality for simultaneous voice, video, and data transmission on a handheld system is achieved.

This data sheet provides details on the functional, operational, and electrical characteristics for the Cypress CYW4356. It is intended for hardware design, application, and OEM engineers.

Cypress Part Numbering Scheme

Cypress is converting the acquired IoT part numbers from Broadcom to the Cypress part numbering scheme. Due to this conversion, there is no change in form, fit, or function as a result of offering the device with Cypress part number marking. The table provides Cypress ordering part number that matches an existing IoT part number.

Table 1. Mapping Table for Part Number between Broadcom and Cypress

Figure 1. Functional Block Diagram

Features

IEEE 802.11X Key Features

- IEEE 802.11ac Draft compliant.
- Dual-stream spatial multiplexing up to 867 Mbps data rate.
- Supports 20, 40, and 80 MHz channels with optional SGI (256 QAM modulation).
- Full IEEE 802.11a/b/g/n legacy compatibility with enhanced performance.
- TX and RX low-density parity check (LDPC) support for improved range and power efficiency.
- Supports IEEE 802.11ac/n beamforming.
- On-chip power amplifiers and low-noise amplifiers for both bands.
- Supports various RF front-end architectures including:
	- ❐ Two antennas with one each dedicated to Bluetooth and WI AN.
	- ❐ Two antennas with WLAN diversity and a shared Bluetooth antenna.
- Shared Bluetooth and WLAN receive signal path eliminates the need for an external power splitter while maintaining excellent sensitivity for both Bluetooth and WLAN.

Bluetooth Key Features

- Qualified for Bluetooth Core Specification 5.0:
	- ❐ QDID: [115131](https://launchstudio.bluetooth.com/ListingDetails/64272)
	- ❐ Declaration ID: [D038396](https://launchstudio.bluetooth.com/ListingDetails/64272)
- Supports Basic Rate (BR), Enhanced Data Rate (EDR) and Bluetooth Low Energy (BLE)
- Bluetooth Class 1 or Class 2 transmitter operation.
- Supports extended synchronous connections (eSCO), for enhanced voice quality by allowing for retransmission of dropped packets.
- Adaptive frequency hopping (AFH) for reducing radio frequency interference.

General Features

- Supports battery range from 3.0V to 5.25V supplies with internal switching regulator
- Programmable dynamic power management
- 484 bytes of user-accessible OTP for storing board parameters
- GPIOs: 11 in WLBGA, 16 in WLCSP
- Package options:
	- ❐ 192-ball WLBGA (4.87 mm × 7.67 mm, 0.4 mm pitch ❐ 395-bump WLCSP (4.87 mm × 7.67 mm, 0.2 mm pitch)
- Internal fractional nPLL allows support for a wide range of reference clock frequencies.
- Supports IEEE 802.15.2 external coexistence interface to optimize bandwidth utilization with other co-located wireless technologies such as LTE or GPS.
- Supports standard SDIO v3.0 (up to SDR104 mode at 208 MHz, 4-bit and 1-bit) host interfaces.
- Backward compatible with SDIO v2.0 host interfaces.
- PCIe mode complies with PCI Express base specification revision 3.0 for ×1 lane and power management running at Gen1 speeds.
- Supports Active State Power Management (ASPM).
- Integrated ARMCR4 processor with tightly coupled memory for complete WLAN subsystem functionality, minimizing the need to wake up the applications processor for standard WLAN functions. This allows for further minimization of power consumption, while maintaining the ability to field upgrade with future features. On-chip memory includes 768 KB SRAM and 640 KB ROM.
- OneDriver[™] software architecture for easy migration from existing embedded WLAN and Bluetooth devices as well as future devices.
- Supports A4WP wireless charging with the BCM59350.
- Interface support, host controller interface (HCI) using a USB or high-speed UART interface and PCM for audio data.
- USB 2.0 full-speed (12 Mbps) supported for Bluetooth.
- Low power consumption improves battery life of handheld devices.
- Supports multiple simultaneous Advanced Audio Distribution Profiles (A2DP) for stereo sound.
- Automatic frequency detection for standard crystal and TCXO values.
- Security:
	- ❐ WPA and WPA2 (Personal) support for powerful encryption and authentication
	- ❐ AES and TKIP in hardware for faster data encryption and IEEE 802.11i compatibility
	- ❐ Reference WLAN subsystem provides Cisco Compatible Extensions (CCX, CCX 2.0, CCX 3.0, CCX 4.0, CCX 5.0)
	- ❐ Reference WLAN subsystem provides Wi-Fi Protected Setup (WPS)
- Worldwide regulatory support: Global products supported with worldwide homologated design.

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1. Overview

1.1 Overview

The Cypress CYW4356/CG8674 single-chip device provides the highest level of integration for an IoT or Embedded system, with integrated IEEE 802.11 a/b/g/n/ac MAC/baseband/radio, Bluetooth 5.0 and Alliance for Wireless Power (A4WP) support. The wireless charging feature works in collaboration with the Wireless Power Transfer (WPT) BCM59350 front-end IC. It provides a small formfactor solution with minimal external components to drive down cost for mass volumes and allows for handheld device flexibility in size, form, and function. Comprehensive power management circuitry and software ensure the system can meet the needs of highly mobile devices that require minimal power consumption and reliable operation.

[Figure 2](#page-5-0) shows the interconnect of all the major physical blocks in the CYW4356/CG8674 and their associated external interfaces, which are described in greater detail in the following sections.

Table 2. Device Options and Features

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1.2 Features

The CYW4356/CG8674 supports the following features:

- IEEE 802.11a/b/g/n/ac dual-band 2x2 MIMO radio with virtual-simultaneous dual-band operation
- Bluetooth 5.0 with integrated Class 1 PA
- Concurrent Bluetooth, and WLAN operation
- On-chip WLAN driver execution capable of supporting IEEE 802.11 functionality
- Single- and dual-antenna support
	- ❐ Single antenna with shared LNA
	- ❐ Simultaneous BT/WLAN receive with single antenna
- WLAN host interface options:
	- ❐ SDIO v3.0 (1 bit/4 bit)—up to 208 MHz clock rate in SDR104 mode
	- ❐ PCIe v3.0 for x1 lane and power management, running at Gen 1 speeds
- BT host digital interface (can be used concurrently with above interfaces): ❐ UART (up to 4 Mbps)
- BT supports full-speed USB 2.0-compliant interface
- ECI—enhanced coexistence support, ability to coordinate BT SCO transmissions around WLAN receives
- I²S/PCM for BT audio
- HCI high-speed UART (H4, H4+, H5) transport support
- Wideband speech support (16 bits linear data, MSB first, left justified at 4K samples/s for transparent air coding, both through I²S and PCM interface)
- **■** Bluetooth SmartAudio[®] technology improves voice and music quality to headsets
- Bluetooth low power inquiry and page scan
- Bluetooth Low Energy (BLE) support
- Bluetooth Packet Loss Concealment (PLC)
- Bluetooth Wideband Speech (WBS)
- Audio rate-matching algorithms
- Multiple simultaneous A2DP audio stream
- A4WP support

1.3 Standards Compliance

The CYW4356/CG8674 supports the following standards:

- Bluetooth 5.0 with Basic Rate (BR), Enhanced Data Rate (EDR) and Bluetooth Low Energy (BLE)
- IEEE802.11ac mandatory and optional requirements for 20 MHz, 40 MHz, and 80 MHz channels
- IEEE 802.11n—Handheld Device Class (Section 11)
- IEEE 802.11a
- IEEE 802.11b
- IEEE 802.11g
- IEEE 802.11d
- IEEE 802.11h
- IEEE 802.11i
- Security:
	- ❐ WEP
	- ❐ WPA Personal
	- ❐ WPA2 Personal
	- ❐ WMM
	- ❐ WMM-PS (U-APSD)
	- ❐ WMM-SA
	- ❐ AES (Hardware Accelerator)
	- ❐ TKIP (HW Accelerator)
	- ❐ CKIP (SW Support)
- Proprietary Protocols:
	- ❐ CCXv2
	- ❐ CCXv3
	- ❐ CCXv4
	- ❐ CCXv5

■ IEEE 802.15.2 Coexistence Compliance—on silicon solution compliant with IEEE 3 wire requirements The CYW4356/CG8674 will support the following future drafts/standards:

- IEEE 802.11w-Secure Management Frames
- A4WP Wireless Power Transfer System Baseline System Specification V1.0
- IEEE 802.11 Extensions:
	- ❐ IEEE 802.11e QoS Enhancements (In accordance with the WMM specification, QoS is already supported.)
	- ❐ IEEE 802.11h 5 GHz Extensions
	- ❐ IEEE 802.11i MAC Enhancements
	- ❐ IEEE 802.11k Radio Resource Measurement

2. Power Supplies and Power Management

2.1 Power Supply Topology

One Buck regulator, multiple LDO regulators, and a power management unit (PMU) are integrated into the CYW4356/CG8674. All regulators are programmable via the PMU. These blocks simplify power supply design for Bluetooth functions in embedded designs.

A single VBAT (3.0V to 5.25V DC max.) and VIO supply (1.8V to 3.3V) can be used, with all additional voltages being provided by the regulators in the CYW4356/CG8674.

Two control signals, BT_REG_ON and WL_REG_ON, are used to power-up the regulators and take the respective section out of reset. The CBUCK CLDO and LNLDO power up when any of the reset signals are deasserted. All regulators are powered down only when both BT_REG_ON and WL_REG_ON are deasserted. The CLDO and LNLDO may be turned off/on based on the dynamic demands of the digital baseband.

The CYW4356/CG8674 allows for an extremely low power-consumption mode by completely shutting down the CBUCK, CLDO, and LNLDO regulators. When in this state, LPLDO1 (which is a low-power linear regulator supplied by the system VIO supply) provides the CYW4356/CG8674 with all the voltages it requires, further reducing leakage currents.

2.2 CYW4356/CG8674 PMU Features

- VBAT to 1.35Vout (600 mA maximum) Core-Buck (CBUCK) switching regulator
- VBAT to 3.3Vout (600 mA maximum) LDO3P3
- VBAT to 3.3Vout (150 mA maximum) LDO3P3_B
- VBAT to 2.5V out (70 mA maximum) BTLDO2P5
- 1.35V to 1.2Vout (150 mA maximum) LNLDO
- 1.35V to 1.2Vout (300 mA maximum) CLDO with bypass mode for deep-sleep
- Additional internal LDOs (not externally accessible)

[Figure 3](#page-9-0) illustrates the typical power topology for the CYW4356/CG8674. The shaded areas are internal to the CYW4356/CG8674.

Figure 3. Typical Power Topology for the CYW4356/CG8674

2.3 WLAN Power Management

The CYW4356/CG8674 has been designed with the stringent power consumption requirements of mobile devices in mind. All areas of the chip design are optimized to minimize power consumption. Silicon processes and cell libraries were chosen to reduce leakage current and supply voltages. Additionally, the CYW4356/CG8674 integrated RAM is a high Vt memory with dynamic clock control. The dominant supply current consumed by the RAM is leakage current only. Additionally, the CYW4356/CG8674 includes an advanced WLAN power management unit (PMU) sequencer. The PMU sequencer provides significant power savings by putting the CYW4356/CG8674 into various power management states appropriate to the current environment and activities that are being performed. The power management unit enables and disables internal regulators, switches, and other blocks based on a computation of the required resources and a table that describes the relationship between resources and the time needed to enable and disable them. Power up sequences are fully programmable. Configurable, free-running counters (running at 32.768 kHz LPO clock) in the PMU sequencer are used to turn on/turn off individual regulators and power switches. Clock speeds are dynamically changed (or gated altogether) for the current mode. Slower clock speeds are used wherever possible.

The CYW4356/CG8674 WLAN power states are described as follows:

- Active mode—All WLAN blocks in the CYW4356/CG8674 are powered up and fully functional with active carrier sensing and frame transmission and receiving. All required regulators are enabled and put in the most efficient mode based on the load current. Clock speeds are dynamically adjusted by the PMU sequencer.
- Deep-sleep mode—Most of the chip including both analog and digital domains and most of the regulators are powered off. All main clocks (PLL, crystal oscillator, or TCXO) are shut down to reduce active power to the minimum. The 32.768 kHz LPO clock is available only for the PMU sequencer. This condition is necessary to allow the PMU sequencer to wake up the chip and transition to Active mode. Logic states in the digital core are saved and preserved into a retention memory in the always-ON domain before the digital core is powered off. Upon a wake-up event triggered by the PMU timers, an external interrupt or a host resumes through the SDIO bus and logic states in the digital core are restored to their pre-deep-sleep settings to avoid lengthy HW reinitialization. In Deep-sleep mode, the primary source of power consumption is leakage current.
- Power-down mode—The CYW4356/CG8674 is effectively powered off by shutting down all internal regulators. The chip is brought out of this mode by external logic reenabling the internal regulators.

2.4 PMU Sequencing

The PMU sequencer is responsible for minimizing system power consumption. It enables and disables various system resources based on a computation of the required resources and a table that describes the relationship between resources and the time needed to enable and disable them.

Resource requests may come from several sources: clock requests from cores, the minimum resources defined in the ResourceMin register, and the resources requested by any active resource request timers. The PMU sequencer maps clock requests into a set of resources required to produce the requested clocks.

Each resource is in one of four states: enabled, disabled, transition on, and transition off and has a timer that contains 0 when the resource is enabled or disabled and a non-zero value in the transition states. The timer is loaded with the time_on or time_off value of the resource when the PMU determines that the resource must be enabled or disabled. That timer decrements on each 32.768 kHz PMU clock. When it reaches 0, the state changes from transition off to disabled or transition on to enabled. If the time on value is 0, the resource can go immediately from disabled to enabled. Similarly, a time_off value of 0 indicates that the resource can go immediately from enabled to disabled. The terms enable sequence and disable sequence refer to either the immediate transition or the timer load-decrement sequence.

During each clock cycle, the PMU sequencer performs the following actions:

- Computes the required resource set based on requests and the resource dependency table.
- Decrements all timers whose values are non zero. If a timer reaches 0, the PMU clears the ResourcePending bit for the resource and inverts the ResourceState bit.
- Compares the request with the current resource status and determines which resources must be enabled or disabled.
- Initiates a disable sequence for each resource that is enabled, no longer being requested, and has no powered up dependents.
- Initiates an enable sequence for each resource that is disabled, is being requested, and has all of its dependencies enabled.

2.5 Power-Off Shutdown

The CYW4356/CG8674 provides a low-power shutdown feature that allows the device to be turned off while the host, and any other devices in the system, remain operational. When the CYW4356/CG8674 is not needed in the system, VDDIO_RF and VDDC are shut down while VBAT and VDDIO remain powered. This allows the CYW4356/CG8674 to be effectively off while keeping the I/O pins powered so that they do not draw extra current from any other devices connected to the I/O.

During a low-power shut-down state, provided VDDIO remains applied to the CYW4356/CG8674, all outputs are tristated, and most inputs signals are disabled. Input voltages must remain within the limits defined for normal operation. This is done to prevent current paths or create loading on any digital signals in the system, and enables the CYW4356/CG8674 to be fully integrated in an embedded device and take full advantage of the lowest power-savings modes.

When the CYW4356/CG8674 is powered on from this state, it is the same as a normal power-up and the device does not retain any information about its state from before it was powered down.

2.6 Power-Up/Power-Down/Reset Circuits

The CYW4356/CG8674 has two signals (see [Table 3](#page-11-3)) that enable or disable the Bluetooth and WLAN circuits and the internal regulator blocks, allowing the host to control power consumption. For timing diagrams of these signals and the required power-up sequences, see [Section 18. Power-Up Sequence and Timing.](#page-131-0)

Table 3. Power-Up/Power-Down/Reset Control Signals

2.7 Wireless Charging

The CYW4356/CG8674 combo IC is designed for paired operation with the BCM59350 wireless power transfer front-end chip. Working together, the two chips form a power receiver unit (PRU) that is compliant with the Alliance for Wireless Power specification (A4WP). High-level functional block diagram for wireless charging is provided in [Figure 4](#page-11-4). The power transmit unit (PTU) resides in the charging pad while the power receive unit is integrated into the mobile device. The charging process begins as the mobile device is placed onto the charging pad. The power is transferred from PTU to PRU through the TX and RX coils by means of magnetic induction. The Bluetooth control link handles communications, i.e., handshaking, between them. PTU is a BLE client, which gets performance data from the BLE server (PRU) in order to adapt its power to the mobile's need.

Further details on the PRU are depicted in [Figure](#page-12-0) 5. It shows both ICs along with a power switch, charger, power management IC, and the application processor (system).

[Figure 6](#page-13-0) shows pin-to-pin connections between the CYW4356/CG8674 and BCM59350, which consist of the following:

- Two Broadcom Serial Control $(BSC)^1$ data and clock lines.
- Two DC power supply lines.
- One interrupt (INTb) to the WLAN chip.
- ■ One GPIO line, which is passed through an OR gate along with another signal from the application processor AP. This is for BT_REG_ON function, as illustrated in [Figure 6.](#page-13-0)

Figure 6. BCM59350 and CYW4356/CG8674 Interface

^{1.} The Broadcom Serial Control bus is a proprietary bus compliant with the Philips I²C bus/interface.

3. Frequency References

An external crystal is used for generating all radio frequencies and normal operation clocking. As an alternative, an external frequency reference may be used. In addition, a low-power oscillator (LPO) is provided for lower power mode timing.

3.1 Crystal Interface and Clock Generation

The CYW4356/CG8674 can use an external crystal to provide a frequency reference. The recommended configuration for the crystal oscillator including all external components is shown in [Figure 7.](#page-14-3) Consult the reference schematics for the latest configuration.

Figure 7. Recommended Oscillator Configuration

A fractional-N synthesizer in the CYW4356/CG8674 generates the radio frequencies, clocks, and data/packet timing, enabling it to operate using a wide selection of frequency references.

For SDIO and PCIe WLAN host applications, the recommended default frequency reference is a 37.4 MHz crystal. For PCIe applications, see [Table 4](#page-15-0) for details on alternatives for the external frequency reference. The signal characteristics for the crystal oscillator interface are also listed in [Table 4](#page-15-0).

Note: Although the fractional-N synthesizer can support alternative reference frequencies, frequencies other than the default require support to be added in the driver, plus additional extensive system testing. Contact Cypress for further details.

3.2 External Frequency Reference

For operation in SDIO mode only, an alternative to a crystal (an external precision frequency reference) can be used. The recommended default frequency is 52 MHz ±10 ppm, and it must meet the phase noise requirements listed in [Table 4](#page-15-0).

If used, the external clock should be connected to the WRF_XTAL_IN pin through an external 1000 pF coupling capacitor, as shown in [Figure 8](#page-14-4). The internal clock buffer connected to this pin will be turned OFF when the CYW4356/CG8674 goes into sleep mode. When the clock buffer turns ON and OFF there will be a small impedance variation. Power must be supplied to the WRF_XTAL_-VDD1P5 pin.

Figure 8. Recommended Circuit to Use with an External Reference Clock

Table 4. Crystal Oscillator and External Clock—Requirements and Performance

a. (Crystal) Use WRF_XTAL_IN and WRF_XTAL_OUT.

b. See [External Frequency Reference](#page-14-2) for alternate connection methods.

c. For a clock reference other than 37.4 MHz, 20 × log10(f/ 37.4) dB should be added to the limits, where f = the reference clock frequency in MHz.

d. BT_TM6 should be tied low for a 52 MHz clock reference. For other frequencies, BT_TM6 should be tied high. Note that 52 MHz is not an

auto–detected frequency using the LPO clock.

e. The frequency step size is approximately 80 Hz resolution.

f. It is the responsibility of the equipment designer to select oscillator components that comply with these specifications.

g. Assumes that external clock has a flat phase noise response above 100 kHz.

h. If the reference clock frequency is <35 MHz the phase noise requirements must be tightened by an additional 2 dB.

3.3 External 32.768 kHz Low-Power Oscillator

The CYW4356/CG8674 uses a secondary low-frequency clock for Low-Power mode timing. Either the internal low- precision LPO or an external 32.768 kHz precision oscillator is required. The internal LPO frequency range is approximately 33 kHz (± 30%) over process, voltage, and temperature, which is adequate for some applications. However, one trade-off caused by this wide LPO tolerance is a small current consumption increase during power save mode that is incurred by the need to wake up earlier to avoid missing beacons.

Whenever possible, the preferred approach is to use a precision external 32.768 kHz clock which meets the requirements listed in [Table 5.](#page-16-1)

Table 5. External 32.768 kHz Sleep Clock Specifications

a. The LPO_IN input has an internal DC blocking capacitor, no external DC blocking is required.

b. The input DC offset must be ≥ 0V to avoid conduction by the ESD protection diode.

c. When power is applied or switched off.

4. Bluetooth Subsystem Overview

The Cypress CYW4356/CG8674 is a Bluetooth 5.0-compliant, baseband processor/2.4 GHz transceiver. It features the highest level of integration and eliminates all critical external components, thus minimizing the footprint, power consumption, and system cost of a Bluetooth radio solution.

The CYW4356/CG8674 is the optimal solution for any Bluetooth voice and/or data application that also requires WLAN. The Bluetooth subsystem presents a standard Host Controller Interface (HCI) via a high-speed UART and PCM for audio. The CYW4356/CG8674 incorporates all Bluetooth 4.1 features including secure simple pairing, sniff subrating, and encryption pause and resume.

The CYW4356/CG8674 Bluetooth radio transceiver provides enhanced radio performance to meet the most stringent mobile phone temperature applications and the tightest integration into mobile handsets and portable devices. It is fully compatible with any of the standard TCXO frequencies and provides full radio compatibility to operate simultaneously with GPS, WLAN, and cellular radios.

The Bluetooth transmitter also features a Class 1 power amplifier with Class 2 capability.

4.1 Features

Major Bluetooth features of the CYW4356/CG8674 include:

- Supports key features of upcoming Bluetooth standards
- Fully supports Bluetooth Core Specification version 4.1 + (Enhanced Data Rate) EDR features:
	- ❐ Adaptive Frequency Hopping (AFH)
	- ❐ Quality of Service (QoS)
	- ❐ Extended Synchronous Connections (eSCO)—Voice Connections
	- ❐ Fast Connect (interlaced page and inquiry scans)
	- ❐ Secure Simple Pairing (SSP)
	- ❐ Sniff Subrating (SSR)
	- ❐ Encryption Pause Resume (EPR)
	- ❐ Extended Inquiry Response (EIR)
	- ❐ Link Supervision Timeout (LST)
- UART baud rates up to 4 Mbps
- Supports all Bluetooth 4.1 packet types

■ Supports Bluetooth 4.2's LE Secure Connections to enable secure connection establishment over BLE using the Elliptic-Curve Diffie-Hellman algorithm2**.**

- Supports maximum Bluetooth data rates over HCI UART
- BT supports full-speed USB 2.0-compliant interface
- Multipoint operation with up to seven active slaves
	- ❐ Maximum of seven simultaneous active ACL links
	- ❐ Maximum of three simultaneous active SCO and eSCO connections with scatternet support
- Trigger Broadcom fast connect (TBFC)
- Narrowband and wideband packet loss concealment
- Scatternet operation with up to four active piconets with background scan and support for scatter mode
- High-speed HCI UART transport support with low-power out-of-band BT_DEV_WAKE and BT_HOST_WAKE signaling (see "Host [Controller Power Management"](#page-21-1))
- Channel quality driven data rate and packet type selection
- **Standard Bluetooth test modes**
- Extended radio and production test mode features
- Full support for power savings modes
	- ❐ Bluetooth clock request
	- ❐ Bluetooth standard sniff
	- ❐ Deep-sleep modes and software regulator shutdown

^{2.} LE Secure Connection is offered via a Cypress provided Bluetooth host/stack implementation

■ TCXO input and auto-detection of all standard handset clock frequencies. Also supports a low-power crystal, which can be used during power-save mode for better timing accuracy.

4.2 Bluetooth Radio

The CYW4356/CG8674 has an integrated radio transceiver that has been optimized for use in 2.4 GHz Bluetooth wireless systems. It has been designed to provide low-power, low-cost, robust communications for applications operating in the globally available 2.4 GHz unlicensed ISM band. It is fully compliant with the Bluetooth Radio Specification and EDR specification and meets or exceeds the requirements to provide the highest communication link quality of service.

4.2.1 Transmit

The CYW4356/CG8674 features a fully integrated zero-IF transmitter. The baseband transmit data is GFSK-modulated in the modem block and upconverted to the 2.4 GHz ISM band in the transmitter path. The transmitter path consists of signal filtering, I/Q upconversion, output power amplifier, and RF filtering. The transmitter path also incorporates $\pi/4$ -DQPSK for 2 Mbps and 8-DPSK for 3 Mbps to support EDR. The transmitter section is compatible to the Bluetooth Low Energy specification. The transmitter PA bias can also be adjusted to provide Bluetooth class 1 or class 2 operation.

4.2.2 Digital Modulator

The digital modulator performs the data modulation and filtering required for the GFSK, π /4-DQPSK, and 8-DPSK signal. The fully digital modulator minimizes any frequency drift or anomalies in the modulation characteristics of the transmitted signal and is much more stable than direct VCO modulation schemes.

4.2.3 Digital Demodulator and Bit Synchronizer

The digital demodulator and bit synchronizer take the low-IF received signal and perform an optimal frequency tracking and bitsynchronization algorithm.

4.2.4 Power Amplifier

The fully integrated PA supports Class 1 or Class 2 output using a highly linearized, temperature-compensated design. This provides greater flexibility in front-end matching and filtering. Due to the linear nature of the PA combined with some integrated filtering, external filtering is required to meet the Bluetooth and regulatory harmonic and spurious requirements. For integrated mobile handset applications in which Bluetooth is integrated next to the cellular radio, external filtering can be applied to achieve near thermal noise levels for spurious and radiated noise emissions. The transmitter features a sophisticated on-chip transmit signal strength indicator (TSSI) block to keep the absolute output power variation within a tight range across process, voltage, and temperature.

4.2.5 Receiver

The receiver path uses a low-IF scheme to downconvert the received signal for demodulation in the digital demodulator and bit synchronizer. The receiver path provides a high degree of linearity, an extended dynamic range, and high-order on-chip channel filtering to ensure reliable operation in the noisy 2.4 GHz ISM band. The front-end topology with built-in out-of-band attenuation enables the CYW4356/CG8674 to be used in most applications with minimal off-chip filtering. For integrated handset operation, in which the Bluetooth function is integrated close to the cellular transmitter, external filtering is required to eliminate the desensitization of the receiver by the cellular transmit signal.

4.2.6 Digital Demodulator and Bit Synchronizer

The digital demodulator and bit synchronizer take the low-IF received signal and perform an optimal frequency tracking and bit synchronization algorithm.

4.2.7 Receiver Signal Strength Indicator

The radio portion of the CYW4356/CG8674 provides a Receiver Signal Strength Indicator (RSSI) signal to the baseband, so that the controller can take part in a Bluetooth power-controlled link by providing a metric of its own receiver signal strength to determine whether the transmitter should increase or decrease its output power.

4.2.8 Local Oscillator Generation

Local Oscillator (LO) generation provides fast frequency hopping (1600 hops/second) across the 79 maximum available channels. The LO generation subblock employs an architecture for high immunity to LO pulling during PA operation. The CYW4356/CG8674 uses an internal RF and IF loop filter.

4.2.9 Calibration

The CYW4356/CG8674 radio transceiver features an automated calibration scheme that is fully self contained in the radio. No user interaction is required during normal operation or during manufacturing to provide the optimal performance. Calibration optimizes the performance of all the major blocks within the radio to within 2% of optimal conditions, including gain and phase characteristics of filters, matching between key components, and key gain blocks. This takes into account process variation and temperature variation. Calibration occurs transparently during normal operation during the settling time of the hops and calibrates for temperature variations as the device cools and heats during normal operation in its environment.

5. Bluetooth Baseband Core

The Bluetooth Baseband Core (BBC) implements all of the time critical functions required for high-performance Bluetooth operation. The BBC manages the buffering, segmentation, and routing of data for all connections. It also buffers data that passes through it, handles data flow control, schedules SCO/ACL TX/RX transactions, monitors Bluetooth slot usage, optimally segments and packages data into baseband packets, manages connection status indicators, and composes and decodes HCI packets. In addition to these functions, it independently handles HCI event types, and HCI command types.

The following transmit and receive functions are also implemented in the BBC hardware to increase reliability and security of the TX/ RX data before sending over the air:

- Symbol timing recovery, data deframing, forward error correction (FEC), header error control (HEC), cyclic redundancy check (CRC), data decryption, and data dewhitening in the receiver.
- Data framing, FEC generation, HEC generation, CRC generation, key generation, data encryption, and data whitening in the transmitter.

5.1 Bluetooth 4.1 Features

The BBC supports all Bluetooth 4.1 features, with the following benefits:

- Dual-mode bluetooth Low Energy (BT and BLE operation)
- Extended Inquiry Response (EIR): Shortens the time to retrieve the device name, specific profile, and operating mode.
- Encryption Pause Resume (EPR): Enables the use of Bluetooth technology in a much more secure environment.
- Sniff Subrating (SSR): Optimizes power consumption for low duty cycle asymmetric data flow, which subsequently extends battery life.
- Secure Simple Pairing (SSP): Reduces the number of steps for connecting two devices, with minimal or no user interaction required.
- Link Supervision Time Out (LSTO): Additional commands added to HCI and Link Management Protocol (LMP) for improved link time-out supervision.
- QoS enhancements: Changes to data traffic control, which results in better link performance. Audio, human interface device (HID), bulk traffic, SCO, and enhanced SCO (eSCO) are improved with the erroneous data (ED) and packet boundary flag (PBF) enhancements.

5.2 Bluetooth 5.0/4.2

- Qualified for Bluetooth 5.0
- **■** Support Bluetooth 4.2's LE Secure Connection feature for Bluetooth low Energy³.

^{3.} LE Secure Connection is offered via a Cypress provided Bluetooth host/stack implementation.

5.3 Link Control Layer

The link control layer is part of the Bluetooth link control functions that are implemented in dedicated logic in the link control unit (LCU). This layer consists of the command controller that takes commands from the software, and other controllers that are activated or configured by the command controller, to perform the link control tasks. Each task performs a different state in the Bluetooth Link Controller.

- Major states:
	- □ Standby
	- ❐ Connection
- Substates:
	- ❐ Page
	- ❐ Page Scan
	- ❐ Inquiry
	- ❐ Inquiry Scan
	- ❐ Sniff

5.4 Test Mode Support

The CYW4356/CG8674 fully supports Bluetooth Test mode as described in Part I:1 of the *Specification of the Bluetooth System Version 3.0*. This includes the transmitter tests, normal and delayed loopback tests, and reduced hopping sequence.

In addition to the standard Bluetooth Test Mode, the CYW4356/CG8674 also supports enhanced testing features to simplify RF debugging and qualification and type-approval testing. These features include:

- Fixed frequency carrier wave (unmodulated) transmission
	- ❐ Simplifies some type-approval measurements (Japan)
- ❐ Aids in transmitter performance analysis
- Fixed frequency constant receiver mode
	- ❐ Receiver output directed to I/O pin
	- ❐ Allows for direct BER measurements using standard RF test equipment
	- ❐ Facilitates spurious emissions testing for receive mode
- Fixed frequency constant transmission
- ❐ Eight-bit fixed pattern or PRBS-9
- ❐ Enables modulated signal measurements with standard RF test equipment

5.5 Bluetooth Power Management Unit

The Bluetooth Power Management Unit (PMU) provides power management features that can be invoked by either software through power management registers or packet handling in the baseband core. The power management functions provided by the CYW4356/ CG8674 are:

- [RF Power Management](#page-21-2)
- [Host Controller Power Management](#page-21-1)
- [BBC Power Management](#page-23-0)

5.5.1 RF Power Management

The BBC generates power-down control signals for the transmit path, receive path, PLL, and power amplifier to the 2.4 GHz transceiver. The transceiver then processes the power-down functions accordingly.

5.5.2 Host Controller Power Management

When running in UART mode, the CYW4356/CG8674 may be configured so that dedicated signals are used for power management hand-shaking between the CYW4356/CG8674 and the host. The basic power saving functions supported by those hand-shaking signals include the standard Bluetooth defined power savings modes and standby modes of operation. [Table 6](#page-21-3) describes the powercontrol hand-shake signals used with the UART interface.

Table 6. Power Control Pin Description

Note: Pad function Control Register is set to 0 for these pins. See ["DC Characteristics](#page-89-0)" for more details.

The timing for the startup sequence is defined in [Figure 9](#page-22-0).

Notes:

T1 is the time for Host to settle it's IOs after a reset.

T2 is the time for Host to drive BT_REG_ON high after the Host IOs are configured.

T3 is the time for BTH (Bluetooth) device to settle its IOs after a reset and reference clock settling time has elapsed .
T4 is the time for BTH device to drive BT_UART_RTS_N low after the Host drives BT_UART_CTS_N low. T completed initialization.

T5 is the time for BTH device to drive CLK_REQ_OUT high after BT_REG_ON goes high. Note this pin is used for designs that use an external reference
clock source from the Host. This pin is irrelevant for Crystal reference c an external crystal connected to it's oscillator circuit.

Timing diagram assumes VBAT is present.

5.5.3 BBC Power Management

The following are low-power operations for the BBC:

- Physical layer packet-handling turns the RF on and off dynamically within transmit/receive packets.
- Bluetooth-specified low-power connection modes: sniff, hold, and park. While in these modes, the CYW4356/CG8674 runs on the low-power oscillator and wakes up after a predefined time period.
- A low-power shutdown feature allows the device to be turned off while the host and any other devices in the system remain operational. When the CYW4356/CG8674 is not needed in the system, the RF and core supplies are shut down while the I/O remains powered. This allows the CYW4356/CG8674 to effectively be off while keeping the I/O pins powered so they do not draw extra current from any other devices connected to the I/O.

During the low-power shut-down state, provided VDDIO remains applied to the CYW4356/CG8674, all outputs are tristated, and most input signals are disabled. Input voltages must remain within the limits defined for normal operation. This is done to prevent current paths or create loading on any digital signals in the system and enables the CYW4356/CG8674 to be fully integrated in an embedded device to take full advantage of the lowest power-saving modes.

Two CYW4356/CG8674 input signals are designed to be high-impedance inputs that do not load the driving signal even if the chip does not have VDDIO power supplied to it: the frequency reference input (WRF_TCXO_IN) and the 32.768 kHz input (LPO). When the CYW4356/CG8674 is powered on from this state, it is the same as a normal power-up, and the device does not contain any information about its state from the time before it was powered down.

5.5.4 FM Power Management

The CYW4356/CG8674 FM subsystem can operate independently of, or in tandem with, the Bluetooth RF and BBC subsystems. The FM subsystem power management scheme operates in conjunction with the Bluetooth RF and BBC subsystems. The FM block does not have a low power state, it is either on or off.

Note: Cypress does not support FM. This section and other sections that refer to FM operation and pinout are retained in this document to provide customers data about the use of Bluetooth while keeping FM powered down.

5.5.5 Wideband Speech

The CYW4356/CG8674 provides support for wideband speech (WBS) using on-chip SmartAudio technology. The CYW4356/CG8674 can perform subband-codec (SBC), as well as mSBC, encoding and decoding of linear 16 bits at 16 kHz (256 Kbps rate) transferred over the PCM bus.

5.5.6 Packet Loss Concealment

Packet Loss Concealment (PLC) improves apparent audio quality for systems with marginal link performance. Bluetooth messages are sent in packets. When a packet is lost, it creates a gap in the received audio bit-stream. Packet loss can be mitigated in several ways:

- Fill in zeros.
- Ramp down the output audio signal toward zero (this is the method used in current Bluetooth headsets).
- Repeat the last frame (or packet) of the received bit-stream and decode it as usual (frame repeat).

These techniques cause distortion and popping in the audio stream. The CYW4356/CG8674 uses a proprietary waveform extension algorithm to provide dramatic improvement in the audio quality. [Figure 10](#page-23-1) and [Figure 11](#page-24-3) show audio waveforms with and without Packet Loss Concealment. Cypress PLC/BEC algorithms also support wideband speech.

Figure 10. CVSD Decoder Output Waveform Without PLC

Figure 11. CVSD Decoder Output Waveform After Applying PLC

5.5.7 Audio Rate-Matching Algorithms

The CYW4356/CG8674 has an enhanced rate-matching algorithm that uses interpolation algorithms to reduce audio stream jitter that may be present when the rate of audio data coming from the host is not the same as the Bluetooth audio data rates.

5.5.8 Codec Encoding

The CYW4356/CG8674 can support SBC and mSBC encoding and decoding for wideband speech.

5.5.9 Multiple Simultaneous A2DP Audio Stream

The CYW4356/CG8674 has the ability to take a single audio stream and output it to multiple Bluetooth devices simultaneously. This allows a user to share his or her music (or any audio stream) with a friend.

5.5.10 Burst Buffer Operation

The CYW4356/CG8674 has a data buffer that can buffer data being sent over the HCI and audio transports, then send the data at an increased rate. This mode of operation allows the host to sleep for the maximum amount of time, dramatically reducing system current consumption.

5.6 Adaptive Frequency Hopping

The CYW4356/CG8674 gathers link quality statistics on a channel by channel basis to facilitate channel assessment and channel map selection. The link quality is determined using both RF and baseband signal processing to provide a more accurate frequencyhop map.

5.7 Advanced Bluetooth/WLAN Coexistence

The CYW4356/CG8674 includes advanced coexistence technologies that are only possible with a Bluetooth/WLAN integrated die solution. These coexistence technologies are targeted at small form-factor platforms, such as cell phones and media players, including applications such as VoWLAN + SCO and Video-over-WLAN + High Fidelity BT Stereo.

Support is provided for platforms that share a single antenna between Bluetooth and WLAN. Dual-antenna applications are also supported. The CYW4356/CG8674 radio architecture allows for lossless simultaneous Bluetooth and WLAN reception for shared antenna applications. This is possible only via an integrated solution (shared LNA and joint AGC algorithm). It has superior performance versus implementations that need to arbitrate between Bluetooth and WLAN reception.

The CYW4356/CG8674 integrated solution enables MAC-layer signaling (firmware) and a greater degree of sharing via an enhanced coexistence interface. Information is exchanged between the Bluetooth and WLAN cores without host processor involvement.

The CYW4356/CG8674 also supports Transmit Power Control on the STA together with standard Bluetooth TPC to limit mutual interference and receiver desensitization. Preemption mechanisms are utilized to prevent AP transmissions from colliding with Bluetooth frames. Improved channel classification techniques have been implemented in Bluetooth for faster and more accurate detection and elimination of interferers (including non-WLAN 2.4 GHz interference).

The Bluetooth AFH classification is also enhanced by the WLAN core's channel information.

5.8 Fast Connection (Interlaced Page and Inquiry Scans)

The CYW4356/CG8674 supports page scan and inquiry scan modes that significantly reduce the average inquiry response and connection times. These scanning modes are compatible with the Bluetooth version 2.1 page and inquiry procedures.

6. Microprocessor and Memory Unit for Bluetooth

The Bluetooth microprocessor core is based on the ARM Cortex-M3 32-bit RISC processor with embedded ICE-RT debug and JTAG interface units. It runs software from the link control (LC) layer, up to the host controller interface (HCI).

The ARM core is paired with a memory unit that contains 668 KB of ROM memory for program storage and boot ROM, 200 KB of RAM for data scratchpad and patch RAM code. The internal ROM allows for flexibility during power-on reset to enable the same device to be used in various configurations. At power-up, the lower-layer protocol stack is executed from the internal ROM memory.

External patches may be applied to the ROM-based firmware to provide flexibility for bug fixes or features additions. These patches may be downloaded from the host to the CYW4356/CG8674 through the UART transports. The mechanism for downloading via UART is identical to the proven interface of the CYW4330 device.

6.1 RAM, ROM, and Patch Memory

The CYW4356/CG8674 Bluetooth core has 200 KB of internal RAM which is mapped between general purpose scratch pad memory and patch memory and 668 KB of ROM used for the lower-layer protocol stack, test mode software, and boot ROM. The patch memory capability enables the addition of code changes for purposes of feature additions and bug fixes to the ROM memory.

6.2 Reset

The CYW4356/CG8674 has an integrated power-on reset circuit that resets all circuits to a known power-on state. The BT power-on reset (POR) circuit is out of reset after BT_REG_ON goes High. If BT_REG_ON is low, then the POR circuit is held in reset.

7. Bluetooth Peripheral Transport Unit

7.1 SPI Interface

The CYW4356/CG8674 supports a slave SPI HCI transport with an input clock range of up to 16 MHz. Higher clock rates can be possible. The physical interface between the SPI master and the CYW4356/CG8674 consists of the four SPI signals (SPI_CSB, SPI_CLK, SPI_SI, and SPI_SO) and one interrupt signal (SPI_INT). The SPI signals are muxed onto the UART signals, see [Table 7](#page-26-4). The CYW4356/CG8674 can be configured to accept active-low or active-high polarity on the SPI_CSB chip select signal. It can also be configured to drive an active-low or active-high SPI_INT interrupt signal. Bit ordering on the SPI_SI and SPI_SO data lines can be configured as either little-endian or big-endian. Additionally, proprietary sleep mode and half-duplex handshaking is implemented between the SPI master and the CYW4356/CG8674. The SPI_INT is required to negotiate the start of a transaction. The SPI interface does not require flow control in the middle of a payload. The FIFO is large enough to handle the largest packet size. Only the SPI master can stop the flow of bytes on the data lines, since it controls SPI_CSB and SPI_CLK. Flow control should be implemented in the higher layer protocols.

Table 7. SPI to UART Signal Mapping

7.2 SPI/UART Transport Detection

The BT_HOST_WAKE (BT_GPIO1) pin is also used for BT transport detection. The transport detection occurs during the power-up sequence. It selects either UART or SPI transport operation based on the following pin state:

- If the BT_HOST_WAKE (BT_GPIO1) pin is pulled low by an external pull-down during power-up, it selects the SPI transport interface.
- If the BT_HOST_WAKE (BT_GPIO1) pin is not pulled low externally during power-up, then the default internal pull-up is detected as a high and it selects the UART transport interface.

When the A4WP feature is *not* used and USB is selected as the Bluetooth interface to the host, an external pull-up (outside the chip) 10 KΩ resistor to BT_VDDIO is required. The pull-up is not necessary but is recommended when the Bluetooth/host interface is UART instead of USB.

7.3 PCM Interface

The CYW4356/CG8674 supports two independent PCM interfaces that share the pins with the I²S interfaces. The PCM Interface on the CYW4356/CG8674 can connect to linear PCM codec devices in master or slave mode. In master mode, the CYW4356/CG8674 generates the PCM_CLK and PCM_SYNC signals, and in slave mode, these signals are provided by another master on the PCM interface and are inputs to the CYW4356/CG8674.

The configuration of the PCM interface may be adjusted by the host through the use of vendor-specific HCI commands.

7.3.1 Slot Mapping

The CYW4356/CG8674 supports up to three simultaneous full-duplex SCO or eSCO channels through the PCM interface. These three channels are time-multiplexed onto the single PCM interface by using a time-slotting scheme where the 8 kHz or 16 kHz audio sample interval is divided into as many as 16 slots. The number of slots is dependent on the selected interface rate of 128 kHz, 512 kHz, or 1024 kHz. The corresponding number of slots for these interface rate is 1, 2, 4, 8, and 16, respectively. Transmit and receive PCM data from an SCO channel is always mapped to the same slot. The PCM data output driver tristates its output on unused slots to allow other devices to share the same PCM interface signals. The data output driver tristates its output after the falling edge of the PCM clock during the last bit of the slot.

7.3.2 Frame Synchronization

The CYW4356/CG8674 supports both short- and long-frame synchronization in both master and slave modes. In short-frame synchronization mode, the frame synchronization signal is an active-high pulse at the audio frame rate that is a single-bit period in width and is synchronized to the rising edge of the bit clock. The PCM slave looks for a high on the falling edge of the bit clock and expects the first bit of the first slot to start at the next rising edge of the clock. In long-frame synchronization mode, the frame synchronization signal is again an active-high pulse at the audio frame rate; however, the duration is three bit periods and the pulse starts coincident with the first bit of the first slot.

7.3.3 Data Formatting

The CYW4356/CG8674 may be configured to generate and accept several different data formats. For conventional narrowband speech mode, the CYW4356/CG8674 uses 13 of the 16 bits in each PCM frame. The location and order of these 13 bits can be configured to support various data formats on the PCM interface. The remaining three bits are ignored on the input and may be filled with 0s, 1s, a sign bit, or a programmed value on the output. The default format is 13-bit 2's complement data, left justified, and clocked MSB first.

7.3.4 Wideband Speech Support

When the host encodes Wideband Speech (WBS) packets in transparent mode, the encoded packets are transferred over the PCM bus for an eSCO voice connection. In this mode, the PCM bus is typically configured in master mode for a 4 kHz sync rate with 16 bit samples, resulting in a 64 Kbps bit rate. The CYW4356/CG8674 also supports slave transparent mode using a proprietary ratematching scheme. In SBC-code mode, linear 16-bit data at 16 kHz (256 Kbps rate) is transferred over the PCM bus.

7.3.5 Burst PCM Mode

In this mode of operation, the PCM bus runs at a significantly higher rate of operation to allow the host to duty cycle its operation and save current. In this mode of operation, the PCM bus can operate at a rate of up to 24 MHz. This mode of operation is initiated with an HCI command from the host.

7.3.6 PCM Interface Timing

Short Frame Sync, Master Mode

Figure 12. PCM Timing Diagram (Short Frame Sync, Master Mode)

Table 8. PCM Interface Timing Specifications (Short Frame Sync, Master Mode)

Short Frame Sync, Slave Mode

Figure 13. PCM Timing Diagram (Short Frame Sync, Slave Mode)

Table 9. PCM Interface Timing Specifications (Short Frame Sync, Slave Mode)

Long Frame Sync, Master Mode

Table 10. PCM Interface Timing Specifications (Long Frame Sync, Master Mode)

Long Frame Sync, Slave Mode

Figure 15. PCM Timing Diagram (Long Frame Sync, Slave Mode)

Table 11. PCM Interface Timing Specifications (Long Frame Sync, Slave Mode)

Short Frame Sync, Burst Mode

Figure 16. PCM Burst Mode Timing (Receive Only, Short Frame Sync)

Table 12. PCM Burst Mode (Receive Only, Short Frame Sync)

Long Frame Sync, Burst Mode

Figure 17. PCM Burst Mode Timing (Receive Only, Long Frame Sync)

Table 13. PCM Burst Mode (Receive Only, Long Frame Sync)

7.4 USB Interface

7.4.1 Features

The following USB interface features are supported:

- USB Protocol, Revision 2.0, full-speed (12 Mbps) compliant including the hub
- Optional hub compound device with up to three device cores internal to device
- Bus or self-power, dynamic configuration for the hub
- Global and selective suspend and resume with remote wakeup
- Bluetooth HCI
- HID, DFU, UHE (proprietary method to emulate an HID device at system bootup)
- Integrated detach resistor

7.4.2 Operation

When the A4WP feature is *not* used and USB is selected as the Bluetooth interface to the host, an external pull-up (outside the chip) 10 KΩ resistor to BT_VDDIO is required. The pull-up is not necessary but is recommended when the Bluetooth/host interface is UART instead of USB.

The CYW4356/CG8674 can be configured to boot up as either a single USB peripheral or a USB hub with several USB peripherals attached. As a single peripheral, the host detects a single USB Bluetooth device. In hub mode, the host detects a hub with one to three of the ports already connected to USB devices (see [Figure 18\)](#page-33-1).

Depending on the desired hub mode configuration, the CYW4356/CG8674 can boot up showing the three ports connected to logical USB devices internal to the CYW4356/CG8674: a generic Bluetooth device, a mouse, and a keyboard. In this mode, the mouse and keyboard are emulated devices, since they connect to real HID devices via a Bluetooth link. The Bluetooth link to these HID devices is hidden from the USB host. To the host, the mouse and/or keyboard appear to be directly connected to the USB port. This Cypress proprietary architecture is called USB HID Emulation (UHE).

The USB device, configuration, and string descriptors are fully programmable, allowing manufacturers to customize the descriptors, including vendor and product IDs, the CYW4356/CG8674 uses to identify itself on the USB port. To make custom USB descriptor information available at boot time, stored it in external NVRAM.

Despite the mode of operation (single peripheral or hub), the Bluetooth device is configured to include the following interfaces:

7.4.3 USB Hub and UHE Support

The CYW4356/CG8674 supports the USB hub and device model (USB, Revision 2.0, full-speed compliant). Optional mouse and keyboard devices utilize Cypress's proprietary USB HID Emulation (UHE) architecture, which allows these devices appear as standalone HID devices even though connected through a Bluetooth link.

The presence of UHE devices requires the hub to be enabled. The CYW4356/CG8674 cannot appear as a single keyboard or a single mouse device without the hub. Once either mouse or keyboard UHE device is enabled, the hub must also be enabled.

When the hub is enabled, the CYW4356/CG8674 handles all standard USB functions for the following devices:

- HID keyboard
- HID mouse
- Bluetooth

All hub and device descriptors are firmware-programmable. This USB compound device configuration (see [Figure 18](#page-33-1)) supports up to three downstream ports. This configuration can also be programmed to a single USB device core. The device automatically detects activity on the USB interface when connected. Therefore, no special configuration is needed to select HCI as the transport.

The hub's downstream port definition is as follows:

- Port 1 USB lite device core (for HID applications)
- Port 2 USB lite device core (for HID applications)
- Port 3 USB full device core (for Bluetooth applications)

When operating in hub mode, all three internal devices do not have to be enabled. Each internal USB device can be optionally enabled. The configuration record in NVRAM determines which devices are present.

7.4.4 USB Full-Speed Timing

[Table 14](#page-34-0) shows timing specifications for the VDD_USB = 3.3V, V_{SS} = 0V, and T_A = 0°C to 85°C operating temperature range.

Figure 19. USB Full-Speed Timing

7.5 UART Interface

The CYW4356/CG8674 has a single UART for Bluetooth. The UART is a standard 4-wire interface (RX, TX, RTS, and CTS) with adjustable baud rates from 9600 bps to 4.0 Mbps. The interface features an automatic baud rate detection capability that returns a baud rate selection. Alternatively, the baud rate may be selected through a vendor-specific UART HCI command.

UART has a 1040-byte receive FIFO and a 1040-byte transmit FIFO to support EDR. Access to the FIFOs is conducted through the AHB interface through either DMA or the CPU. The UART supports the Bluetooth 5.0 UART HCI specification: H4, a custom Extended H4, and H5. The default baud rate is 115.2 Kbaud.

The UART supports the 3-wire H5 UART transport, as described in the Bluetooth specification ("Three-wire UART Transport Layer"). Compared to H4, the H5 UART transport reduces the number of signal lines required by eliminating the CTS and RTS signals.

The CYW4356/CG8674 UART can perform XON/XOFF flow control and includes hardware support for the Serial Line Input Protocol (SLIP). It can also perform wake-on activity. For example, activity on the RX or CTS inputs can wake the chip from a sleep state.

Normally, the UART baud rate is set by a configuration record downloaded after device reset, or by automatic baud rate detection, and the host does not need to adjust the baud rate. Support for changing the baud rate during normal HCI UART operation is included through a vendor-specific command that allows the host to adjust the contents of the baud rate registers. The CYW4356/CG8674 UARTs operate correctly with the host UART as long as the combined baud rate error of the two devices is within ±2%.

Table 15. Example of Common Baud Rates

Figure 20. UART Timing

Table 16. UART Timing Specifications

7.6 I2S Interface

The CYW4356/CG8674 supports 1^2S digital audio port for Bluetooth audio. The 1^2S signals are:

- \blacksquare \lvert ²S clock: BT_I2S_CLK
- I²S Word Select: BT_I2S_WS
- I²S Data Out: BT_I2S_DO
- I²S Data In: BT_I2S_DI

BT_I2S_CLK and BT_I2S_WS become outputs in master mode and inputs in slave mode, whereas BT_I2S_DO always stays as an output. The channel word length is 16 bits, and the data is justified so that the MSB of the left-channel data is aligned with the MSB of the I²S bus, in accord with the I²S specification. The MSB of each data word is transmitted one bit clock cycle after the BT_I2S_WS transition, synchronous with the falling edge of the bit clock. Left-channel data is transmitted when IBT_I2S_WS is low, and rightchannel data is transmitted when BT_I2S_WS is high. Data bits sent by the CYW4356/CG8674 are synchronized with the falling edge of BT_I2S_CLK and should be sampled by the receiver on the rising edge of BT_I2S_CLK.

The clock rate in master mode is either of the following:

48 kHz x 32 bits per frame = 1.536 MHz

48 kHz x 50 bits per frame = 2.400 MHz

The master clock is generated from the input reference clock using a N/M clock divider.

In the slave mode, any clock rate is supported to a maximum of 3.072 MHz.

7.6.1 I2S Timing

Note: Timing values specified in [Table 17](#page-37-4) are relative to high and low threshold levels.

Table 17. Timing for I2S Transmitters and Receivers

a. The system clock period T must be greater than T_{tr} and T_r because both the transmitter and receiver have to be able to handle the data transfer rate.

b. At all data rates in master mode, the transmitter or receiver generates a clock signal with a fixed mark/space ratio. For this reason, t_{HC} and t_{LC} are specified with respect to T.

c. In slave mode, the transmitter and receiver need a clock signal with minimum HIGH and LOW periods so that they can detect the signal. So long as the minimum periods are greater than $0.35T_r$, any clock that meets the requirements can be used.

d. Because the delay (t_{dtr}) and the maximum transmitter speed (defined by T_{tr}) are related, a fast transmitter driven by a slow clock edge can result in t_{dtr} not exceeding t_{RC} which means t_{htr} becomes zero or negative. Therefore, the transmitter has to guarantee that t_{htr} is greater than or equal to zero, so long as the clock rise-time t_{RC} is not more than t_{RCmax} , where t_{RCmax} is not less than 0.15T_{tr}.

e. To allow data to be clocked out on a falling edge, the delay is specified with respect to the rising edge of the clock signal and T, always giving the receiver sufficient setup time.

f. The data setup and hold time must not be less than the specified receiver setup and hold time.

Note: The time periods specified in [Figure 21](#page-38-0) and [Figure 22](#page-38-1) are defined by the transmitter speed. The receiver specifications must match transmitter performance.

Figure 21. I2S Transmitter Timing

T = Clock period

 T_{tr} = Minimum allowed clock period for transmitter

 $T = T_{tr}$

 $*$ t_{RC} is only relevant for transmitters in slave mode.

Figure 22. I2S Receiver Timing

T = Clock period

 T_r = Minimum allowed clock period for transmitter

 $T > T_r$

7.7 External Coexistence Interface

An external handshake interface is available to enable signaling between the device and an external co-located wireless device, such as GPS, LTE, or UWB, to manage wireless medium sharing for optimal performance.

Figure 27 and [Figure 24](#page-39-0) show the LTE coexistence interface (including UART) for each CYW4356/CG8674 package type. See [Table 27](#page-84-0) for further details on multiplexed signals, such as the GPIO pins.

See [Table 16](#page-36-0) for the UART baud rate.

Notes:

 OR'ing to generate ISM_RX_PRIORITY for ERCX_TXCONF or BT_RX_PRIORITY is achieved by setting the GPIO mask registers appropriately.

H SECI_OUT and SECI_IN are multiplexed on the GPIOs.

Figure 24. Legacy 3-Wire LTE Coexistence Interface

Note: OR'ing to generate WCN_PRIORITY FOR ERCX_TXCONF or BT_RX_PRIORITY is achieved by setting the GPIO mask registers appropriately.

7.8 UART Interface

One 2-wire UART interface can be enabled by software as an alternate function on GPIO pins. Refer to [Table 27.](#page-84-0) Provided primarily for debugging during development, this UART enables the CYW4356/CG8674 to operate as RS-232 data termination equipment (DTE) for exchanging and managing data with other serial devices. It is compatible with the industry standard 16550 UART, and provides a FIFO size of 64 × 8 in each direction.

7.9 JTAG Interface

The CYW4356/CG8674 supports the IEEE 1149.1 JTAG boundary scan standard for performing device package and PCB assembly testing during manufacturing. In addition, the JTAG interface allows Cypress to assist customers by using proprietary debug and characterization test tools during board bring-up. Therefore, it is highly recommended to provide access to the JTAG pins by means of test points or a header on all PCB designs.

Refer to [Table 27](#page-84-0) for JTAG pin assignments.

7.10 SPROM Interface

Various hardware configuration parameters may be stored in an external SPROM instead of the OTP. The SPROM is read by system software after device reset. In addition, depending on the board design, customer-specific parameters may be stored in SPROM.

The four SPROM control signals —SPROM_CS, SPROM_CLK, SPROM_MI, and SPROM_MO are multiplexed on the SDIO interface (see [Table 27](#page-84-0) for additional details). By default, the SPROM interface supports 2 Kbit serial SPROMs, and it can also support 4 Kbit and 16 Kbit serial SPROMs by using the appropriate strapping option.

8. WLAN Host Interfaces

8.1 SDIO v3.0

All three package options of the CYW4356/CG8674 WLAN section provide support for SDIO version 3.0, including the new UHS-I modes:

- DS: Default speed (DS) up to 25 MHz, including 1- and 4-bit modes (3.3V signaling).
- HS: High-speed up to 50 MHz (3.3V signaling).
- SDR12: SDR up to 25 MHz (1.8V signaling).
- SDR25: SDR up to 50 MHz (1.8V signaling).
- SDR50: SDR up to 100 MHz (1.8V signaling).
- SDR104: SDR up to 208 MHz (1.8V signaling)
- DDR50: DDR up to 50 MHz (1.8V signaling).

Note: The CYW4356/CG8674 is backward compatible with SDIO v2.0 host interfaces.

The SDIO interface also has the ability to map the interrupt signal on to a GPIO pin for applications requiring an interrupt different from the one provided by the SDIO interface. The ability to force control of the gated clocks from within the device is also provided. SDIO mode is enabled by strapping options. Refer to [Table 24](#page-83-0) WLAN GPIO Functions and Strapping Options.

The following three functions are supported:

- Function 0 Standard SDIO function (max. BlockSize/ByteCount = 32B)
- Function 1 Backplane Function to access the internal system-on-chip (SoC) address space (max. BlockSize/ByteCount = 64B)
- Function 2 WLAN Function for efficient WLAN packet transfer through DMA (max. BlockSize/ByteCount = 512B)

8.1.1 SDIO Pins

Figure 25. Signal Connections to SDIO Host (SD 4-Bit Mode)

Figure 26. Signal Connections to SDIO Host (SD 1-Bit Mode)

Note: Per Section 6 of the SDIO specification, pull-ups in the 10 kΩ to 100 kΩ range are required on the four DATA lines and the CMD line. This requirement must be met during all operating states either through the use of external pull-up resistors or through proper programming of the SDIO host's internal pull-ups.

8.2 PCI Express Interface

The PCI Express (PCIe) core on the CYW4356/CG8674 is a high-performance serial I/O interconnect that is protocol compliant and electrically compatible with the *PCI Express Base Specification v3.0* running at Gen1 speeds. This core contains all the necessary blocks, including logical and electrical functional subblocks to perform PCIe functionality and maintain high-speed links, using existing PCI system configuration software implementations without modification.

Organization of the PCIe core is in logical layers: Transaction Layer, Data Link Layer, and Physical Layer, as shown in [Figure 27.](#page-43-0) A configuration or link management block is provided for enumerating the PCIe configuration space and supporting generation and reception of System Management Messages by communicating with PCIe layers.

Each layer is partitioned into dedicated transmit and receive units that allow point-to-point communication between the host and CYW4356/CG8674 device. The transmit side processes outbound packets whereas the receive side processes inbound packets. Packets are formed and generated in the Transaction and Data Link Layer for transmission onto the high-speed links and onto the receiving device. A header is added at the beginning to indicate the packet type and any other optional fields.

Figure 27. PCI Express Layer Model

8.2.1 Transaction Layer Interface

The PCIe core employs a packet-based protocol to transfer data between the host and CYW4356/CG8674 device, delivering new levels of performance and features. The upper layer of the PCIe is the Transaction Layer. The Transaction layer is primarily responsible for assembly and disassembly of Transaction Layer Packets (TLPs). TLP structure contains header, data payload, and End-to-End CRC (ECRC) fields, which are used to communicate transactions, such as read and write requests and other events.

A pipelined full split-transaction protocol is implemented in this layer to maximize efficient communication between devices with creditbased flow control of TLP, which eliminates wasted link bandwidth due to retries.

8.2.2 Data Link Layer

The data link layer serves as an intermediate stage between the transaction layer and the physical layer. Its primary responsibility is to provide reliable, efficient mechanism for the exchange of TLPs between two directly connected components on the link. Services provided by the data link layer include data exchange, initialization, error detection and correction, and retry services.

Data Link Layer Packets (DLLPs) are generated and consumed by the data link layer. DLLPs are the mechanism used to transfer link management information between data link layers of the two directly connected components on the link, including TLP acknowledgement, power management, and flow control.

8.2.3 Physical Layer

The physical layer of the PCIe provides a handshake mechanism between the data link layer and the high-speed signaling used for Link data interchange. This layer is divided into the logical and electrical functional subblocks. Both subblocks have dedicated transmit and receive units that allow for point-to-point communication between the host and CYW4356/CG8674 device. The transmit section prepares outgoing information passed from the data link layer for transmission, and the receiver section identifies and prepares received information before passing it to the data link layer. This process involves link initialization, configuration, scrambler, and data conversion into a specific format.

8.2.4 Logical Subblock

The logical sub block primary functions are to prepare outgoing data from the data link layer for transmission and identify received data before passing it to the data link layer.

8.2.5 Scrambler/Descrambler

This PCIe PHY component generates pseudo-random sequence for scrambling of data bytes and the idle sequence. On the transmit side, scrambling is applied to characters prior to the 8b/10b encoding. On the receive side, descrambling is applied to characters after 8b/10b decoding. Scrambling may be disabled in polling and recovery for testing and debugging purposes.

8.2.6 8B/10B Encoder/Decoder

The PCIe core on the CYW4356/CG8674 uses an 8b/10b encoder/decoder scheme to provide DC balancing, synchronizing clock and data recovery, and error detection. The transmission code is specified in the ANSI X3.230-1994, clause 11 and in IEEE 802.3z, 36.2.4.

Using this scheme, 8-bit data characters are treated as 3 bits and 5 bits mapped onto a 4-bit code group and a 6-bit code group, respectively. The control bit in conjunction with the data character is used to identify when to encode one of the twelve Special Symbols included in the 8b/10b transmission code. These code groups are concatenated to form a 10-bit symbol, which is then transmitted serially. Special Symbols are used for link management, frame TLPs, and DLLPs, allowing these packets to be quickly identified and easily distinguished.

8.2.7 Elastic FIFO

An elastic FIFO is implemented in the receiver side to compensate for the differences between the transmit clock domain and the receive clock domain, with worse case clock frequency specified at 600 ppm tolerance. As a result, the transmit and receive clocks can shift one clock every 1666 clocks. In addition, the FIFO adaptively adjusts the elastic level based on the relative frequency difference of the write and read clock. This technique reduces the elastic FIFO size and the average receiver latency by half.

8.2.8 Electrical Subblock

The high-speed signals utilize the Common Mode Logic (CML) signaling interface with on-chip termination and de-emphasis for bestin-class signal integrity. A de-emphasis technique is employed to reduce the effects of Intersymbol Interference (ISI) due to the interconnect by optimizing voltage and timing margins for worst case channel loss. This results in a maximally open "eye" at the detection point, thereby allowing the receiver to receive data with acceptable Bit-Error Rate (BER).

To further minimize ISI, multiple bits of the same polarity that are output in succession are de-emphasized. Subsequent same bits are reduced by a factor of 3.5 dB in power. This amount is specified by PCIe to allow for maximum interoperability while minimizing the complexity of controlling the de-emphasis values. The high-speed interface requires AC coupling on the transmit side to eliminate the DC common mode voltage from the receiver. The range of AC capacitance allowed is 75 nF to 200 nF.

8.2.9 Configuration Space

The PCIe function in the CYW4356/CG8674 implements the configuration space as defined in the *PCI Express Base Specification v3.0*.

9. Wireless LAN MAC and PHY

9.1 IEEE 802.11ac Draft MAC

The CYW4356/CG8674 WLAN MAC is designed to support high-throughput operation with low-power consumption. It does so without compromising the Bluetooth coexistence policies, thereby enabling optimal performance over both networks. In addition, several power saving modes have been implemented that allow the MAC to consume very little power while maintaining network-wide timing synchronization. The architecture diagram of the MAC is shown in [Figure 28.](#page-45-0)

The following sections provide an overview of the important modules in the MAC.

Figure 28. WLAN MAC Architecture

The CYW4356/CG8674 WLAN media access controller (MAC) supports features specified in the IEEE 802.11 base standard, and amended by IEEE 802.11n. The key MAC features include:

- Enhanced MAC for supporting IEEE 802.11ac Draft features
- Transmission and reception of aggregated MPDUs (A-MPDU) for high throughput (HT)
- Support for power management schemes, including WMM power-save, power-save multi-poll (PSMP) and multiphase PSMP operation
- Support for immediate ACK and Block-ACK policies
- Interframe space timing support, including RIFS
- Support for RTS/CTS and CTS-to-self frame sequences for protecting frame exchanges
- Back-off counters in hardware for supporting multiple priorities as specified in the WMM specification
- Timing synchronization function (TSF), network allocation vector (NAV) maintenance, and target beacon transmission time (TBTT) generation in hardware
- Hardware offload for AES-CCMP, legacy WPA TKIP, legacy WEP ciphers, WAPI, and support for key management
- Support for coexistence with Bluetooth and other external radios
- Programmable independent basic service set (IBSS) or infrastructure basic service set functionality
- Statistics counters for MIB support

PSM

The programmable state machine (PSM) is a micro-coded engine, which provides most of the low-level control to the hardware, to implement the IEEE 802.11 specification. It is a microcontroller that is highly optimized for flow control operations, which are predominant in implementations of communication protocols. The instruction set and fundamental operations are simple and general, which allows algorithms to be optimized until very late in the design process. It also allows for changes to the algorithms to track evolving IEEE 802.11 specifications.

The PSM fetches instructions from the microcode memory. It uses the shared memory to obtain operands for instructions, as a data store, and to exchange data between both the host and the MAC data pipeline (via the SHM bus). The PSM also uses a scratchpad memory (similar to a register bank) to store frequently accessed and temporary variables.

The PSM exercises fine-grained control over the hardware engines, by programming internal hardware registers (IHR). These IHRs are co-located with the hardware functions they control, and are accessed by the PSM via the IHR bus.

The PSM fetches instructions from the microcode memory using an address determined by the program counter, instruction literal, or a program stack. For ALU operations the operands are obtained from shared memory, scratchpad, IHRs, or instruction literals, and the results are written into the shared memory, scratchpad, or IHRs.

There are two basic branch instructions: conditional branches and ALU based branches. To better support the many decision points in the IEEE 802.11 algorithms, branches can depend on either a readily available signals from the hardware modules (branch condition signals are available to the PSM without polling the IHRs), or on the results of ALU operations.

WEP

The wired equivalent privacy (WEP) engine encapsulates all the hardware accelerators to perform the encryption and decryption, and MIC computation and verification. The accelerators implement the following cipher algorithms: legacy WEP, WPA TKIP, WPA2 AES-CCMP.

The PSM determines, based on the frame type and association information, the appropriate cipher algorithm to be used. It supplies the keys to the hardware engines from an on-chip key table. The WEP interfaces with the TXE to encrypt and compute the MIC on transmit frames, and the RXE to decrypt and verify the MIC on receive frames.

TXE

The transmit engine (TXE) constitutes the transmit data path of the MAC. It coordinates the DMA engines to store the transmit frames in the TXFIFO. It interfaces with WEP module to encrypt frames, and transfers the frames across the MAC-PHY interface at the appropriate time determined by the channel access mechanisms.

The data received from the DMA engines are stored in transmit FIFOs. The MAC supports multiple logical queues to support traffic streams that have different QoS priority requirements. The PSM uses the channel access information from the IFS module to schedule a queue from which the next frame is transmitted. Once the frame is scheduled, the TXE hardware transmits the frame based on a precise timing trigger received from the IFS module.

The TXE module also contains the hardware that allows the rapid assembly of MPDUs into an A-MPDU for transmission. The hardware module aggregates the encrypted MPDUs by adding appropriate headers and pad delimiters as needed.

RXE

The receive engine (RXE) constitutes the receive data path of the MAC. It interfaces with the DMA engine to drain the received frames from the RXFIFO. It transfers bytes across the MAC-PHY interface and interfaces with the WEP module to decrypt frames. The decrypted data is stored in the RXFIFO.

The RXE module contains programmable filters that are programmed by the PSM to accept or filter frames based on several criteria such as receiver address, BSSID, and certain frame types.

The RXE module also contains the hardware required to detect A-MPDUs, parse the headers of the containers, and disaggregate them into component MPDUS.

IFS

The IFS module contains the timers required to determine interframe space timing including RIFS timing. It also contains multiple backoff engines required to support prioritized access to the medium as specified by WMM.

The interframe spacing timers are triggered by the cessation of channel activity on the medium, as indicated by the PHY. These timers provide precise timing to the TXE to begin frame transmission. The TXE uses this information to send response frames or perform transmit frame-bursting (RIFS or SIFS separated, as within a TXOP).

The backoff engines (for each access category) monitor channel activity, in each slot duration, to determine whether to continue or pause the backoff counters. When the backoff counters reach 0, the TXE gets notified, so that it may commence frame transmission. In the event of multiple backoff counters decrementing to 0 at the same time, the hardware resolves the conflict based on policies provided by the PSM.

The IFS module also incorporates hardware that allows the MAC to enter a low-power state when operating under the IEEE power save mode. In this mode, the MAC is in a suspended state with its clock turned off. A sleep timer, whose count value is initialized by the PSM, runs on a slow clock and determines the duration over which the MAC remains in this suspended state. Once the timer expires the MAC is restored to its functional state. The PSM updates the TSF timer based on the sleep duration ensuring that the TSF is synchronized to the network.

The IFS module also contains the PTA hardware that assists the PSM in Bluetooth coexistence functions.

TSF

The timing synchronization function (TSF) module maintains the TSF timer of the MAC. It also maintains the target beacon transmission time (TBTT). The TSF timer hardware, under the control of the PSM, is capable of adopting timestamps received from beacon and probe response frames in order to maintain synchronization with the network.

The TSF module also generates trigger signals for events that are specified as offsets from the TSF timer, such as uplink and downlink transmission times used in PSMP.

NAV

The network allocation vector (NAV) timer module is responsible for maintaining the NAV information conveyed through the duration field of MAC frames. This ensures that the MAC complies with the protection mechanisms specified in the standard.

The hardware, under the control of the PSM, maintains the NAV timer and updates the timer appropriately based on received frames. This timing information is provided to the IFS module, which uses it as a virtual carrier-sense indication.

MAC-PHY Interface

The MAC-PHY interface consists of a data path interface to exchange RX/TX data from/to the PHY. In addition, there is an programming interface, which can be controlled either by the host or the PSM to configure and control the PHY.

9.2 IEEE 802.11ac Draft PHY

The CYW4356/CG8674 WLAN Digital PHY is designed to comply with IEEE 802.11ac Draft and IEEE 802.11a/b/g/n dual-stream specifications to provide wireless LAN connectivity supporting data rates from 1 Mbps to 866.7 Mbps for low-power, high-performance handheld applications.

The PHY has been designed to work in the presence of interference, radio nonlinearity, and various other impairments. It incorporates optimized implementations of the filters, FFT and Viterbi decoder algorithms. Efficient algorithms have been designed to achieve maximum throughput and reliability, including algorithms for carrier sense/rejection, frequency/phase/timing acquisition and tracking, channel estimation and tracking. The PHY receiver also contains a robust IEEE 802.11b demodulator. The PHY carrier sense has been tuned to provide high throughput for IEEE 802.11g/11b hybrid networks with Bluetooth coexistence. It has also been designed for sharing an antenna between WL and BT to support simultaneous RX-RX.

The key PHY features include:

- Programmable data rates from MCS0–15 in 20 MHz, 40 MHz, and 80 MHz channels, as specified in IEEE 802.11ac Draft
- Supports Optional Short GI and Green Field modes in TX and RX
- TX and RX LDPC for improved range and power efficiency
- Beamforming support
- All scrambling, encoding, forward error correction, and modulation in the transmit direction and inverse operations in the receive direction.
- Supports IEEE 802.11h/k for worldwide operation
- Advanced algorithms for low power, enhanced sensitivity, range, and reliability

- Algorithms to improve performance in presence of Bluetooth
- Closed loop transmit power control
- Digital RF chip calibration algorithms to handle CMOS RF chip non-idealities
- On-the-fly channel frequency and transmit power selection
- Supports per packet RX antenna diversity
- Available per-packet channel quality and signal strength measurements
- Designed to meet FCC and other worldwide regulatory requirements

Figure 29. WLAN PHY Block Diagram

10. WLAN Radio Subsystem

The CYW4356/CG8674 includes an integrated dual-band WLAN RF transceiver that has been optimized for use in 2.4 GHz and 5 GHz Wireless LAN systems. It has been designed to provide low-power, low-cost, and robust communications for applications operating in the globally available 2.4 GHz unlicensed ISM or 5 GHz U-NII bands. The transmit and receive sections include all on-chip filtering, mixing, and gain control functions.

Sixteen RF control signals are available (eight per core) to drive external RF switches and support optional external power amplifiers and low-noise amplifiers for each band. See the reference board schematics for further details.

A block diagram of the radio subsystem (core 0) is shown in [Figure 30](#page-50-0). Core 1, is identical to Core 0 without the Bluetooth blocks. Note that integrated on-chip baluns (not shown) convert the fully differential transmit and receive paths to single-ended signal pins.

Figure 30. Radio Functional Block Diagram (Core 0)

10.1 Receiver Path

The CYW4356/CG8674 has a wide dynamic range, direct conversion receiver that employs high order on-chip channel filtering to ensure reliable operation in the noisy 2.4 GHz ISM band or the entire 5 GHz U-NII band. An on-chip low noise amplifier (LNA) in the 2.4 GHz path in core 0 is shared between the Bluetooth and WLAN receivers, whereas the 5 GHz receive path and the core 1 2.4 GHz receive path have dedicated on-chip LNAs. Control signals are available that can support the use of external LNAs for each band, which can increase the receive sensitivity by several dB.

10.2 Transmit Path

Baseband data is modulated and upconverted to the 2.4 GHz ISM or 5 GHz U-NII bands, respectively. Linear on-chip power amplifiers are included, which are capable of delivering high output power while meeting IEEE 802.11ac and IEEE 802.11a/b/g/n specifications, and without the need for external PAs. When using the internal PAs, closed-loop output power control is completely integrated.

10.3 Calibration

The CYW4356/CG8674 features dynamic and automatic on-chip calibration to continually compensate for temperature and process variations across components. These calibration routines are performed periodically in the course of normal radio operation. Examples of some of the automatic calibration algorithms are baseband filter calibration for optimum transmit and receive performance, and LOFT calibration for carrier leakage reduction. In addition, I/Q Calibration, R Calibration, and VCO Calibration are performed on-chip. No per-board calibration is required in manufacturing test, which helps to minimize the test time and cost in large volume production.

11. Pin Information

11.1 Ball Maps

[Figure 31](#page-52-0) shows the WLBGA ball map.

Figure 31. CYW4356/CG8674 A2 WLBGA BALL MAP; 12 × 18 Array; 192 Balls; Bottom View (Balls Facing Up)

11.2 Pin Lists

Table 19. Pin List by Pin Number (192-Pin WLBGA Package)

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Table 19. Pin List by Pin Number (192-Pin WLBGA Package)

Table 19. Pin List by Pin Number (192-Pin WLBGA Package)

Table 20. Pin List by Pin Name (192-Pin WLBGA Package)

Table 20. Pin List by Pin Name (192-Pin WLBGA Package)

Table 20. Pin List by Pin Name (192-Pin WLBGA Package)

Table 20. Pin List by Pin Name (192-Pin WLBGA Package)

Table 21. 395-Bump WLCSP Coordinates

11.3 Signal Descriptions

The signal name, type, and description of each pin in the CYW4356/CG8674 is listed in [Table 22](#page-69-0) and [Table 23](#page-76-0). The symbols shown under Type indicate pin directions (I/O = bidirectional, I = input, O = output) and the internal pull-up/pull-down characteristics (PU = weak internal pull-up resistor and PD = weak internal pull-down resistor), if any.

Table 22. WLCSP Signal Descriptions

Table 22. WLCSP Signal Descriptions (Cont.)

Table 22. WLCSP Signal Descriptions (Cont.)

a. Note: Cypress does not support FM on CYW4356/CG8674

Table 23. WLBGA Signal Descriptions

a. Cypress does not support FM on CYW4356/CG8674.

11.4 WLAN/BT GPIO Signals and Strapping Options

The pins listed in [Table 24](#page-83-0) and [Table 25](#page-83-2) are sampled at power-on reset (POR) to determine the various operating modes. Sampling occurs a few milliseconds after an internal POR or deassertion of the external POR. After the POR, each pin assumes the GPIO or alternative function specified in the signal descriptions table. Each strapping option pin has an internal pull-up (PU) or pull-down (PD) resistor that determines the default mode. To change the mode, connect an external PU resistor to VDDIO or a PD resistor to GND, using a 10 kΩ resistor or less.

Note: Refer to the reference board schematics for more information.

Table 24. WLAN GPIO Functions and Strapping Options

Table 25. BT GPIO Functions and Strapping Options

Table 26. GPIO_[10, 9, 8] Host Interface Selection

11.5 GPIO Alternative Signal Functions

Note: For all new designs, use GPIO_6 for SECI_IN instead of GPIO_4. For existing designs, GPIO_4 can be still used for SECI_IN provided the strapping requirements discussed in ["WLAN/BT GPIO Signals and Strapping Options](#page-83-3)" are fully satisfied.

Table 27. GPIO Alternative Signal Functions

Table 27. GPIO Alternative Signal Functions (Cont.)

a. For all new designs, use GPIO_6 for SECI_IN instead of GPIO_4. For existing designs, GPIO_4 can be still used for SECI_IN provided the strapping requirements discussed in "[WLAN/](#page-83-3) [BT GPIO Signals and Strapping Options](#page-83-3)" are fully satisfied.

[Table](#page-85-1) 28 defines status for all CYW4356/CG8674 GPIOs based on the tristate test mode.

Table 28. GPIO Status Vs. Test Modes

11.6 I/O States

The following notations are used in [Table](#page-86-0) 29:

- I: Input signal
- O: Output signal
- I/O: Input/Output signal
- PU = Pulled up
- PD = Pulled down
- NoPull = Neither pulled up nor pulled down
- Where applicable, the default value is shown in bold brackets (for example, **[default value]**)

Table 29. I/O States

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Table 29. I/O States (Cont.)

Table 29. I/O States (Cont.)

a. Keeper column: N = pad has no keeper. Y = pad has a keeper. Keeper is always active except in Power-down state. If there is no keeper, and it is an input and there is Nopull, then the pad should be driven to prevent leakage due to floating pad (for example, SDIO_CLK).

b. In the Power-down state (xx_REG_ON=0): High-Z; NoPull => the pad is disabled because power is not supplied.

c. Depending on whether the PCM interface is enabled and the configuration of PCM is in master or slave mode, it can be either input or output.

d. Depending on whether the I^2S interface is enabled and the configuration of I^2S is in master or slave mode, it can be either input or output.

e. For WLBGA these GPIOs have a PD in all states. For WLCSP these GPIOs have a PU in all states.

12. DC Characteristics

12.1 Absolute Maximum Ratings

Caution! The absolute maximum ratings in [Table 30](#page-89-1) indicate levels where permanent damage to the device can occur, even if these limits are exceeded for only a brief duration. Functional operation is not guaranteed under these conditions. Operation at absolute maximum conditions for extended periods can adversely affect long-term reliability of the device.

Table 30. Absolute Maximum Ratings

a. The maximum continuous voltage is 5.25V. Voltage transients up to 6.0V for up to 10 seconds, cumulative duration over the lifetime of the device, are allowed. Voltage transients as high as 5.5V for up to 250 seconds, cumulative duration over the lifetime of the device, are allowed.

b. Duration not to exceed 25% of the duty cycle.

12.2 Environmental Ratings

The environmental ratings are shown in [Table 31.](#page-89-2)

Table 31. Environmental Ratings

a. Functionality is guaranteed but specifications require derating at extreme temperatures; see the specification tables for details.

12.3 Electrostatic Discharge Specifications

Extreme caution must be exercised to prevent electrostatic discharge (ESD) damage. Proper use of wrist and heel grounding straps to discharge static electricity is required when handling these devices. Always store the unused material in its antistatic packaging.

Table 32. ESD Specifications

12.4 Recommended Operating Conditions and DC Characteristics

Caution! Functional operation is not guaranteed outside of the limits shown in [Table 33,](#page-90-0) and operation outside these limits for extended periods can adversely affect long-term reliability of the device.

Table 33. Recommended Operating Conditions and DC Characteristics

a. The CYW4356/CG8674 is functional across this range of voltages. Optimal RF performance specified in the data sheet, however, is guaranteed only for 3.13V < VBAT < 4.8V.

b. The maximum continuous voltage is 5.25V. Voltage transients up to 6.0V for up to 10 seconds, cumulative duration over the lifetime of the device, are allowed. Voltage transients as high as 5.5V for up to 250 seconds, cumulative duration over the lifetime of the device, are allowed. c. Programmable 2 mA to 16 mA drive strength. Default is 10 mA.

13. Bluetooth RF Specifications

Unless otherwise stated, limit values apply for the conditions specified in [Table 31](#page-89-2) and [Table 33](#page-90-0). Typical values apply for an ambient temperature of +25°C.

Figure 32. RF Port Location for Bluetooth Testing

Note: All Bluetooth specifications are measured at the chip port unless otherwise specified.

Table 34. Bluetooth Receiver RF Specifications

Table 34. Bluetooth Receiver RF Specifications (Cont.)

Table 34. Bluetooth Receiver RF Specifications (Cont.)

a. The maximum value represents the actual Bluetooth specification required for Bluetooth qualification as defined in the v5.0 specification.

b. Bluetooth reference level for the wanted signal at the Bluetooth Chip port = at 3 dB desense for each data rate.

c. Interferer: 2560 MHz, BW=10 MHz; measured at 2480 MHz.

d. Interferer: 2360 MHz, BW=10 MHz; measured at 2402 MHz.

e. Interferer: 2380 MHz, BW=10 MHz; measured at 2480 MHz.

f. Interferer: 2355 MHz, BW=10 MHz; measured at 2480 MHz.

Table 35. Bluetooth Transmitter RF Specifications

a. The typical number is measured at ±3 MHz offset.

b. The maximum value represents the value required for Bluetooth qualification as defined in the v5.0 specification.

c. The spurious emissions during Idle mode are the same as specified in [Table 35.](#page-95-0)

d. Specified at the Bluetooth Antenna port.

e. Meets this specification using a front-end band-pass filter.

f. Transmitted power in cellular and FM bands at the Bluetooth Antenna port. See [Figure 32](#page-91-0) for location of the port.

Table 36. Local Oscillator Performance

a. This pattern represents an average deviation in payload.

b. Pattern represents the maximum deviation in payload for 99.9% of all frequency deviations.

Table 37. BLE RF Specifications

a. Dirty TX is On.

b. BLE TX power can be increased to compensate for front-end losses such as BPF, duplexer, switch, etc.). The output is capped at 12 dBm out. The BLE TX power at the antenna port cannot exceed the 10 dBm specification limit.

c. At least 99.9% of all delta F2 max. frequency values recorded over 10 packets must be greater than 185 kHz.

14. WLAN RF Specifications

14.1 Introduction

The CYW4356/CG8674 includes an integrated dual-band direct conversion radio that supports the 2.4 GHz and the 5 GHz bands. This section describes the RF characteristics of the 2.4 GHz and 5 GHz radios.

Unless otherwise stated, limit values apply for the conditions specified in[Table 31](#page-89-2) and [Table 33](#page-90-0). Typical values apply for an ambient temperature +25°C.

14.2 2.4 GHz Band General RF Specifications

14.3 WLAN 2.4 GHz Receiver Performance Specifications

Note: The values in [Table 39](#page-98-0) are specified at the RF port unless otherwise noted.

a. Derate by 1.5 dB for –30°C to –10°C and 55°C to 85°C.

b. Sensitivity degradations for alternate settings in MCS modes. MM: 0.5 dB drop, and SGI: 2 dB drop.

c. The cellular standard listed for each band indicates the type of modulation used to generate the interfering signal in that band for the purpose of this test. It is not intended to indicate any specific usage of each band in any specific country.

d. The blocking levels are valid for channels 1 to 11. (For higher channels, the performance may be lower due to third harmonic signals (3 × 824 MHz) falling within band.)

e. The minimum and maximum values shown have a 95% confidence level.

14.4 WLAN 2.4 GHz Transmitter Performance Specifications

Note: The values in [Table 40](#page-103-3) are specified at the RF port unless otherwise noted.

Table 40. WLAN 2.4 GHz Transmitter Performance Specifications

Table 40. WLAN 2.4 GHz Transmitter Performance Specifications (Cont.)

a. The cellular standards listed only indicate the typical usages of that band in some countries: other standards may also be used within those bands.

b. Derate by 1.5 dB for –30°C to –10°C and 55°C to 85°C, or supply voltages lower than 3.0V. Derate by 3.0 dB for supply voltages of lower than 2.7V, or supply voltages lower than 3.0V at –30°C to –10°C and 55°C to 85°C.

14.5 WLAN 5 GHz Receiver Performance Specifications

Note: The values in [Table 41](#page-105-0) are specified at the RF port unless otherwise noted.

Table 41. WLAN 5 GHz Receiver Performance Specifications

Table 41. WLAN 5 GHz Receiver Performance Specifications (Cont.)

Table 41. WLAN 5 GHz Receiver Performance Specifications (Cont.)

Table 41. WLAN 5 GHz Receiver Performance Specifications (Cont.)

a. Derate by 1.5 dB for –30°C to –10°C and 55°C to 85°C.

b. The cellular standard listed for each band indicates the type of modulation used to generate the interfering signal in that band for the purpose of this test. It is not intended to indicate any specific usage of each band in any specific country.

c. The cellular standard listed for each band indicates the type of modulation used to generate the interfering signal in that band for the purpose of this test. It is not intended to indicate any specific usage of each band in any specific country.

d. The blocking levels are valid for channels 1 to 11. (For higher channels, the performance may be lower due to third harmonic signals (3 × 824 MHz) falling within band.)

e. For 65 Mbps, the size is 4096.

f. The minimum and maximum values shown have a 95% confidence level.

14.6 WLAN 5 GHz Transmitter Performance Specifications

Note: The values in [Table 42](#page-111-0) are specified at the RF port unless otherwise noted.

Table 42. WLAN 5 GHz Transmitter Performance Specifications

a. The cellular standards listed indicate only typical usages of that band in some countries. Other standards may also be used within those bands.

b. Derate by 1.5 dB for –30°C to –10°C and 55°C to 85°C, or supply voltages lower than 3.0V. Derate by 3.0 dB for supply voltages of lower than 2.7V, or supply voltages lower than 3.0V at –30°C to –10°C and 55°C to 85°C.

15. Internal Regulator Electrical Specifications

Functional operation is not guaranteed outside of the specification limits provided in this section.

15.1 Core Buck Switching Regulator

Table 43. Core Buck Switching Regulator (CBUCK) Specifications

a. The maximum continuous voltage is 5.25V. Voltages up to 6.0V for up to 10 seconds, cumulative duration, over the lifetime of the device are allowed. Voltages as high as 5.5V for up to 250 seconds, cumulative duration, over the lifetime of the device are allowed.

b. Minimum capacitor value refers to the residual capacitor value after taking into account the part–to–part tolerance, DC–bias, temperature, and aging.

c. Total capacitance includes those connected at the far end of the active load.

15.2 3.3V LDO (LDO3P3)

Table 44. LDO3P3 Specifications

a. The maximum continuous voltage is 5.25V. Voltages up to 6.0V for up to 10 seconds, cumulative duration, over the lifetime of the device are allowed. Voltages as high as 5.5V for up to 250 seconds, cumulative duration, over the lifetime of the device are allowed.

b. Minimum capacitor value refers to the residual capacitor value after taking into account the part-to-part tolerance, DC-bias, temperature, and aging.

15.3 3.3V LDO (LDO3P3_B)

Table 45. LDO3P3_B Specifications

a. The maximum continuous voltage is 5.25V. Voltages up to 6.0V for up to 10 seconds, cumulative duration, over the lifetime of the device are allowed. Voltages as high as 5.5V for up to 250 seconds, cumulative duration, over the lifetime of the device are allowed.

b. Minimum capacitor value refers to the residual capacitor value after taking into account the part–to–part tolerance, DC–bias, temperature, and aging.

15.4 2.5V LDO (BTLDO2P5)

Table 46. BTLDO2P5 Specifications

a. The maximum continuous voltage is 5.25V. Voltages up to 6.0V for up to 10 seconds, cumulative duration, over the lifetime of the device are allowed. Voltages as high as 5.5V for up to 250 seconds, cumulative duration, over the lifetime of the device are allowed.

b. The minimum value refers to the residual capacitor value after taking into account part–to–part tolerance, DC–bias, temperature, and aging.

15.5 CLDO

Table 47. CLDO Specifications

a. Minimum capacitor value refers to the residual capacitor value after taking into account the part–to–part tolerance, DC–bias, temperature, and aging.

15.6 LNLDO

Table 48. LNLDO Specifications

a. Minimum capacitor value refers to the residual capacitor value after taking into account the part–to–part tolerance, DC–bias, temperature, and aging.

16. System Power Consumption

Note: Unless otherwise stated, these values apply for the conditions specified in [Table 33.](#page-90-0)

16.1 WLAN Current Consumption

The WLAN current consumption measurements are shown in [Table 49](#page-118-0). All values in [Table 49](#page-118-0) are with the Bluetooth core in reset (that is, Bluetooth is OFF). .

Table 49. Typical WLAN Power Consumption

Table 49. Typical WLAN Power Consumption (Cont.)

a. Specified with all pins idle (not switching) and not driving any loads.

b. WL_REG_ON and BT_REG_ON low.

c. Idle, not associated, or inter-beacon.

d. Beacon Interval = 102.4 ms. Beacon duration = 1 ms @1 Mbps. Average current over three DTIM intervals.

e. Output power per core at RF port = 21 dBm

f. Duty cycle is 100%.

g. Measured using packet engine test mode.

h. Output power per core at RF port = 17 dBm.

i. Output power per core at RF port = 17.5 dBm.

j. Output power per core at RF port = 14 dBm.

k. Duty cycle is 100%. Carrier sense (CS) detect/packet receive.

l. Carrier sense (CCA) when no carrier is present.

16.2 Bluetooth Current Consumption

The Bluetooth current consumption measurements are shown in [Table 50](#page-120-1). **Note:**

- The WLAN core is in reset (WLAN_REG_ON = low) for all measurements provided in [Table 50.](#page-120-1)
- The BT current consumption numbers are measured based on GFSK TX output power = 10 dBm.

Table 50. Bluetooth Current Consumption

a. At maximum class 1 TX power, 500 ms sniff, four attempts (slave), P = 1.28s, and I = 2.56s.

b. No devices present. A 1.28 second interval with a scan window of 11.25 ms.

17. Interface Timing and AC Characteristics

17.1 SDIO Timing

17.1.1 SDIO Default Mode Timing

SDIO default mode timing is shown by the combination of [Figure 34](#page-121-0) and [Table 51](#page-122-0).

Figure 34. SDIO Bus Timing (Default Mode)

Table 51. SDIO Bus Timing^a Parameters (Default Mode)

a. Timing is based on CL ≤ 40pF load on CMD and Data.

b. Min. (Vih) = $0.7 \times$ VDDIO and max. (Vil) = $0.2 \times$ VDDIO.

17.1.2 SDIO High-Speed Mode Timing

SDIO high-speed mode timing is shown by the combination of [Figure 35](#page-122-1) and [Table 52.](#page-123-0)

Figure 35. SDIO Bus Timing (High-Speed Mode)

Table 52. SDIO Bus Timing^a Parameters (High-Speed Mode)

a. Timing is based on CL ≤ 40pF load on CMD and Data.

b. Min. (Vih) = $0.7 \times$ VDDIO and max. (Vil) = $0.2 \times$ VDDIO.

Clock Timing

Figure 36. SDIO Clock Timing (SDR Modes)

^{17.1.3} SDIO Bus Timing Specifications in SDR Modes

Device Input Timing

Figure 37. SDIO Bus Input Timing (SDR Modes)

Table 54. SDIO Bus Input Timing Parameters (SDR Modes)

Figure 38. SDIO Bus Output Timing (SDR Modes up to 100 MHz)

Device Output Timing

Table 55. SDIO Bus Output Timing Parameters (SDR Modes up to 100 MHz)

Figure 39. SDIO Bus Output Timing (SDR Modes 100 MHz to 208 MHz)

Table 56. SDIO Bus Output Timing Parameters (SDR Modes 100 MHz to 208 MHz)

- $\triangle t_{OP}$ = +1550 ps for junction temperature of Δt_{OP} = 90 degrees during operation
- $\triangle t_{OP}$ = –350 ps for junction temperature of Δt_{OP} = –20 degrees during operation
- \triangle Δt_{OP} = +2600 ps for junction temperature of Δt_{OP} = -20 to +125 degrees during operation

Figure 40. Δt_{OP} Consideration for Variable Data Window (SDR 104 Mode)

17.1.4 SDIO Bus Timing Specifications in DDR50 Mode

Data Timing, DDR50 Mode

Figure 42. SDIO Data Timing (DDR50 Mode)

Table 58. SDIO Bus Timing Parameters (DDR50 Mode)

17.2 PCI Express Interface Parameters

Table 59. PCI Express Interface Parameters

Table 59. PCI Express Interface Parameters (Cont.)

a. For out-of-band PCIe signal specifications, refer to [Table 33.](#page-90-0)

b. The reference clock inputs comply with the requirements of the *PCI Express CEM v2.0 Specification* (see [References\)](#page-141-0).

17.3 JTAG Timing

Table 60. JTAG Timing Characteristics

18. Power-Up Sequence and Timing

18.1 Sequencing of Reset and Regulator Control Signals

The CYW4356/CG8674 has two signals that allow the host to control power consumption by enabling or disabling the Bluetooth, WLAN, and internal regulator blocks. These signals are described below. Additionally, diagrams are provided to indicate proper sequencing of the signals for various operational states (see [Figure 43](#page-131-0), [Figure 44](#page-132-0), and [Figure 45](#page-132-1) and [Figure 46\)](#page-133-0). The timing values indicated are minimum required values; longer delays are also acceptable.

18.1.1 Description of Control Signals

- **WL_REG_ON**: Used by the PMU to power up the WLAN section. It is also OR-gated with the BT_REG_ON input to control the internal CYW4356/CG8674 regulators. When this pin is high, the regulators are enabled and the WLAN section is out of reset. When this pin is low the WLAN section is in reset. If both the BT_REG_ON and WL_REG_ON pins are low, the regulators are disabled.
- **BT_REG_ON**: Used by the PMU (OR-gated with WL_REG_ON) to power up the internal CYW4356/CG8674 regulators. If both the BT_REG_ON and WL_REG_ON pins are low, the regulators are disabled. When this pin is low and WL_REG_ON is high, the BT section is in reset.

Note:

- For both the WL_REG_ON and BT_REG_ON pins, there should be at least a 10 ms time delay between consecutive toggles (where both signals have been driven low). This is to allow time for the CBUCK regulator to discharge. If this delay is not followed, then there may be a VDDIO in-rush current on the order of 36 mA during the next PMU cold start.
- The CYW4356/CG8674 has an internal power-on reset (POR) circuit. The device will be held in reset for a maximum of 110 ms after VDDC and VDDIO have both passed the POR threshold. Wait at least 150 ms after VDDC and VDDIO are available before initiating SDIO accesses.
- VBAT should not rise 10%–90% faster than 40 microseconds. VBAT should be up before or at the same time as VDDIO. VDDIO should NOT be present first or be held high before VBAT is high.

18.1.2 Control Signal Timing Diagrams

Figure 43. WLAN = ON, Bluetooth = ON

***Notes:**

1. VBAT should not rise 10%–90% faster than 40 microseconds.

Figure 44. WLAN = OFF, Bluetooth = OFF

***Notes:**

1. VBAT should not rise 10%–90% faster than 40 microseconds.

2. VBAT should be up before or at the same time as VDDIO. VDDIO should NOT be present first or be held high before VBAT is high.

Figure 45. WLAN = ON, Bluetooth = OFF

***Notes:**

1. VBAT should not rise 10%–90% faster than 40 microseconds.

Figure 46. WLAN = OFF, Bluetooth = ON

1. VBAT should not rise 10%–90% faster than 40 microseconds.

18.1.3 Power-up Sequences

[Figure 47](#page-134-0) shows the WLAN boot-up sequence from power-up to firmware download.

Figure 47. WLAN Boot-Up Sequence

***Notes:**

1. VBAT should not rise 10%–90% faster than 40 microseconds.

[Figure 48](#page-135-0) and [Table 61](#page-135-1) show the WLAN/PCIe power-up timing.

Figure 48. WLAN/PCIe Power-Up Timing

Table 61. Timing Parameters

19. Package Information

19.1 Package Thermal Characteristics

The information in [Table 62](#page-136-0) and [Table 63](#page-136-1) is based on the following conditions:

- No heat sink, T_A = 70°C. This is an estimate, based on a 4-layer PCB that conforms to EIA/JESD51–7 (101.6 mm \times 101.6 mm \times 1.6 mm) and P = 1.53W continuous dissipation.
- Absolute junction temperature limits are maintained through active thermal monitoring and driver-based techniques that may include duty-cycle limiting or turning off one of the TX chains, or both.

Table 62. WLCSP Package Thermal Characteristics

Table 63. WLBGA Package Thermal Characteristics

19.2 Junction Temperature Estimation and PSI_{JT} Versus Theta_{JC}

The package thermal characterization parameter PSI_{JT} (ψ_{J}) yields a better estimation of actual junction temperature (T_J) than using the junction-to-case thermal resistance parameter Theta_{JC} ($\theta_{\rm JC}$). The reason for this is that $\theta_{\rm JC}$ is based on the assumption that all the power is dissipated through the top surface of the package case. In actual applications, however, some of the power is dissipated through the bottom and sides of the package. V_{JT} takes into account the power dissipated through the top, bottom, and sides of the package. The equation for calculating the device junction temperature is:

$$
T_J = T_T + P \times \mathcal{V}_{JT}
$$

Where:

- \blacksquare T_J = Junction temperature at steady-state condition (°C)
- \blacksquare T_T = Package case top center temperature at steady-state condition (°C)
- \blacksquare P = Device power dissipation (Watts)
- \blacksquare \mathcal{Y}_{JT} = Package thermal characteristics; no airflow (°C/W)

19.3 Environmental Characteristics

For environmental characteristics data, see [Table 31](#page-89-0).

20. Mechanical Information

Figure 49. 192-Ball WLBGA Package Mechanical Information

$\overline{10}$ ∞ Lŋ $\overline{}$ ာ $\overline{11}$ $\overline{12}$ $\overline{}$ \sim 4 \circ ∞ \blacktriangleleft \prec $\bf \Omega$ $\boldsymbol{\underline{\omega}}$ \cup \cup $\mathop\square$ $\mathop\square$ Ш ш Щ \mathbf{L} \circ O $\mathbf T$ $\mathbf T$ $\overline{}$ $($ \blacksquare \geq \geq $\overline{}$ $\overline{}$ $\overline{}$ $\mathbf{\Sigma}% _{t}\left(t\right)$ $\mathsf{\Sigma}$ $\mathsf Z$ $\mathsf z$ \mathbf{r} \mathbf{r} \propto \propto \vdash \vdash \Rightarrow \supset \geq \geq ∞ \overline{a} $\overline{10}$ $\overline{1}$ 12 4 \circ $\overline{}$ ∞ σ $\overline{}$ \sim - Routing Keep-Out

Figure 50. WLBGA Keep-Out Areas for PCB Layout (Top View, Balls Facing Down)

Figure 51. 395-Bump WLCSP Package

Filename: MOD01857-001

PRIMARY DATUM Z AND SEATING PLANE ARE DEFINED BY
THE SPHERICAL CROWNS OF THE SOLDER BALLS.

DIMENSION IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER,
PARALLEL TO PRIMARY DATUM Z. $\mathcal{H}_{5} \setminus$

MINIMUM BUMP PITCH IS 0.200MM $4₁$

 $\sqrt{6}$

REFER TO BROADCOM APPLICATION NOTE "WAFER-SCALE CHIP-SIZED
PACKAGE (WSCSP) OVERVIEW AND ASSEMBLY GUIDELINES FOR DESIGN,
IMPLEMENTATION, AND MANUFACTURING RECOMMENDATIONS AND GUIDELINES. $3.$ BUMP POSITION DESIGNATION PER JESD 95-1, SPP-010 $2.$

ALL DIMENSIONS AND TOLERANCES CONFORM TO ASME Y14.5M-1994. $\mathbf{1}$. NOTES: UNLESS OTHERWISE SPECIFIED

Figure 52. WLCSP Keep-Out Areas for PCB Layout (Top View, Balls Facing Down)

21. Ordering Information

a. CG8674AA (BCM4356XKUBG) has been pruned by Cypress. Cypress ships CG8674BA (CYW4356XKUBG) part instead. This is the exact same part with the "CYW" prefix in marking i.e. Cypress marking.

Note: Add "T" suffix to part numbers mentioned in the table above to order in Tape and Reel

22. Additional Information

22.1 Acronyms and Abbreviations

In most cases, acronyms and abbreviations are defined on first use.

For a comprehensive list of acronyms and other terms used in Cypress documents, go to:

<http://www.cypress.com/glossary>

22.2 References

The references in this section may be used in conjunction with this document.

Note: Cypress provides customer access to technical documentation and software through its Cypress Developer Community and Downloads and Support site (see IoT Resources).

For Cypress documents, replace the "xx" in the document number with the largest number available in the repository to ensure that you have the most current version of the document.

23. IoT Resources

Cypress provides a wealth of data at <http://www.cypress.com/internet-things-iot>to help you to select the right IoT device for your design, and quickly and effectively integrate the device into your design. Cypress provides customer access to a wide range of information, including technical documentation, schematic diagrams, product bill of materials, PCB layout information, and software updates. Customers can acquire technical documentation and software from the Cypress Support Community website (http://community.cypress.com/).

Document History

